Service Manual

Caller ID Compatible



Telephone Equipment

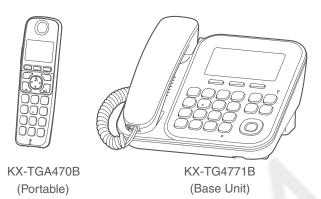
Model No. **KX-TG4771B KX-TG4772B**

KX-TG4773B

KX-TGA470B

Digital Corded/Cordless Answering System

B: Black Version (for U.S.A.)





Configuration for each model

Model No	Base Unit	Portable	Charger Unit	Expandable
KX-TG4771	1 (TG4771)	1 (TGA470)	1	Up to 6
KX-TG4772	1 (TG4771)	2 (TGA470)	2	Up to 6
KX-TG4773	1 (TG4771)	3 (TGA470)	3	Up to 6
KX-TGA470*		1 (TGA470)	1	

*KX-TGA470 is also an optional accessory, which contains a portable and a charger.



⚠ WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

- IMPORTANT SAFETY NOTICE

There are special components used in this equipment which are important for safety. These parts are marked by \triangle in the Schematic Diagrams, Circuit Board Diagrams, Exploded Views and Replacement Parts List. It is essential that these critical parts should be replaced with manufacturer's specified parts to prevent shock, fire or other hazards. Do not modify the original design without permission of manufacturer.

IMPORTANT INFORMATION ABOUT LEAD FREE, (PbF), SOLDERING

If lead free solder was used in the manufacture of this product, the printed circuit boards will be marked PbF. Standard leaded, (Pb), solder can be used as usual on boards without the PbF mark. When this mark does appear, please read and follow the special instructions described in this manual on the use of PbF and how it might be permissible to use Pb solder during service and repair work.

- When you note the serial number, write down all 11 digits. The serial number may be found on the bottom of the unit.
- The illustrations in this Service Manual may vary slightly from the actual product.

TABLE OF CONTENTS

			PAGE
1	Safet	y Precautions	4
		For Service Technicians	
2	Warn	ing	4
		Battery Caution	
		About Lead Free Solder (PbF: Pb free)	
	2.3.	Discarding of P. C. Board	5
3	Speci	ifications	6
4	Techr	nical Descriptions	7
	4.1.	US-DECT Description	7
	4.2.	Block Diagram (Base Unit_Main)	9
		Block Diagram (Base Unit_RF Part)	
	4.4.	Circuit Operation (Base Unit)	11
		Block Diagram (Portable)	
		Block Diagram (Portable_RF Part)	
		Circuit Operation (Portable)	
	4.8.	Circuit Operation (Charger Unit)	20
_		Signal Route	
		tion of Controls and Components	
		lation Instructions	
		ating Instructions	
8		Mode	
		Engineering Mode	
9		ce Mode	
		How to Clear User Setting (Portable Only)	
10		bleshooting Guide	
		Troubleshooting Flowchart	
11	Disas	sembly and Assembly Instructions	43
		Disassembly Instructions	
	11.2.	Assembly Instructions	4/
40		How to Replace the Portable LCD	
12	weas	urements and Adjustments Equipment Required	40
		The Setting Method of JIG	
		Adjustment Standard (Charger Unit)	
		Adjustment Standard (Charger Unit)Adjustment Standard (Portable)	
	12.5.	Things to Do after Replacing IC or X'tal	55
12	Micos	Frequency Table	00 50
13		How to Replace the LLP (Leadless Leadframe	
	13.1.	Package) IC	
	13.2	How to Replace the Flat Package IC	
		Terminal Guide of the ICs, Transistors and	
	10.0.	Diodes	
14	Sche	matic Diagram	
		For Schematic Diagram	
		Base Unit (Main)	
		Base Unit (Operation)	
		Base Unit (LED)	
		Portable (Main)	
		Portable (LED)	
		Charger Unit	
15		ed Circuit Board	
		Base Unit (Main)	
		Base Unit (Operation)	
		Base Unit (LED)	
		Portable (Main)	
		Portable (LED)	
			55

	PAGE
15.6. Charger Unit	84
16 Exploded View and Replacement Parts List	85
16.1. Cabinet and Electrical Parts (Base Unit)	85
16.2. Cabinet and Electrical Parts (Portable)	86
16.3. Cabinet and Electrical Parts (Charger Unit)	87
16.4. Accessories and Packing Materials	88
16.5 Replacement Parts List	92

1 Safety Precautions

1.1. For Service Technicians

- Repair service shall be provided in accordance with repair technology information such as service manual so as to prevent fires, injury or electric shock, which can be caused by improper repair work.
 - 1. When repair services are provided, neither the products nor their parts or members shall be remodeled.
 - 2. If a lead wire assembly is supplied as a repair part, the lead wire assembly shall be replaced.
 - 3. FASTON terminals shall be plugged straight in and unplugged straight out.
- · ICs and LSIs are vulnerable to static electricity.

When repairing, the following precautions will help prevent recurring malfunctions.

- 1. Cover plastic parts boxes with aluminum foil.
- 2. Ground the soldering irons.
- 3. Use a conductive mat on worktable.
- 4. Do not grasp IC or LSI pins with bare fingers.

2 Warning

2.1. Battery Caution

Risk of explosion if battery is replaced by an incorrect type. Dispose of used batteries according to the instructions.

Attention:



A nickel metal hydride battery that is recyclable powers the product you have purchased. Please call 1-800-8-BATTERY (1-800-822-8837) for information on how to recycle this battery.

2.2. About Lead Free Solder (PbF: Pb free)

Note:

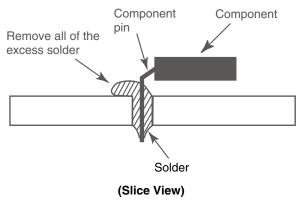
In the information below, Pb, the symbol for lead in the periodic table of elements, will refer to standard solder or solder that contains lead

We will use PbF solder when discussing the lead free solder used in our manufacturing process which is made from Tin (Sn), Silver (Ag), and Copper (Cu).

This model, and others like it, manufactured using lead free solder will have PbF stamped on the PCB. For service and repair work we suggest using the same type of solder.

Caution

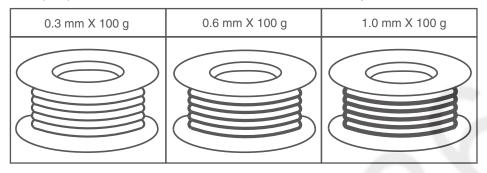
- PbF solder has a melting point that is 50 °F \sim 70 °F (30 °C \sim 40 °C) higher than Pb solder. Please use a soldering iron with temperature control and adjust it to 700 °F \pm 20 °F (370 °C \pm 10 °C).
- Exercise care while using higher temperature soldering irons.:
 - Do not heat the PCB for too long time in order to prevent solder splash or damage to the PCB.
- PbF solder will tend to splash if it is heated much higher than its melting point, approximately 1100 °F (600 °C).
- When applying PbF solder to double layered boards, please check the component side for excess which may flow onto the
 opposite side (See the figure below).



2.2.1. Suggested PbF Solder

There are several types of PbF solder available commercially. While this product is manufactured using Tin, Silver, and Copper (Sn+Ag+Cu), you can also use Tin and Copper (Sn+Cu), or Tin, Zinc, and Bismuth (Sn+Zn+Bi). Please check the manufacturer's specific instructions for the melting points of their products and any precautions for using their product with other materials.

The following lead free (PbF) solder wire sizes are recommended for service of this product: 0.3 mm, 0.6 mm and 1.0 mm.



2.3. Discarding of P. C. Board

When discarding P. C. Board, delete all personal information such as telephone directory and caller list or scrap P. C. Board.

3 Specifications

■ Standard:

DECT 6.0 (Digital Enhanced Cordless

Telecommunications 6.0)

■ Number of channels: 60 Duplex Channels

■ Frequency range:

1.92 GHz to 1.93 GHz

■ Duplex procedure:

TDMA (Time Division Multiple Access)

■ Channel spacing:

1,728 MHz

■ Bit rate:

1,152 kbit/s

■ Modulation:

GFSK (Gaussian Frequency Shift Keying)

■ RF transmission power:

115 mW (max.)

■ Voice coding:

ADPCM 32 kbit/s

	Base Unit	Portable	Charger
Power source	AC Adaptor	Rechargeable Ni-MH battery	AC Adaptor
	(PNLV226Z, 120 V AC, 60 Hz)	AAA (R03) size (1.2 V 550 mAh)	(PNLV226Z, 120 V AC, 60 Hz)
Receiving Method	Super Heterodyne	Super Heterodyne	
Oscillation Method	PLL synthesizer	PLL synthesizer	
Detecting Method	Quadrature Discriminator	Quadrature Discriminator	
Tolerance of OSC Frequency	13.824 MHz ± 83 Hz	13.824 MHz ± 83 Hz	_
Modulation Method	Frequency Modulation	Frequency Modulation	_
ID Code	40 bit	40 bit	_
Ringer Equivalence No. (REN)	1.0B	_	
Dialing Mode	Tone (DTMF)/Pulse	Tone (DTMF)/Pulse	_
Redial	Up to 48 digits	Up to 48 digits	
Speed Dialer	Up to 24 digits (Phonebook)	Up to 24 digits (Phonebook)	
Power Consumption	Standby: Approx. 0.9 W	11 days at Standby,	Standby: Approx. 0.1 W,
	Maximum: Approx. 1.5 W	13 hours at Talk	Maximum: Approx. 2.0 W
Operating Conditions	0 °C - 40 °C (32 °F – 104 °F)	0 °C - 40 °C (32 °F – 104 °F)	0 °C - 40 °C (32 °F – 104 °F)
	20 % – 80 % relative air humidity	20 % – 80 % relative air humidity	20 % – 80 % relative air humidity
	(dry)	(dry)	(dry)
Dimensions (H x W x D)	Approx. 111 mm x 186 mm x 197 mm	Approx. 174 mm x 54 mm x 34 mm	Approx. 43 mm x 73 mm x 76 mm
Mass (Weight)	Approx. 650 g	Approx. 150 g	Approx. 50 g

Note:

• Design and specifications are subject to change without notice.

Note for Service:

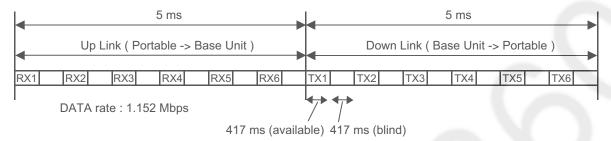
- Operation range: Up to 300 m outdoors, Up to 50 m indoors, depending on the condition.
- Analog telephone connection: Telephone Line
- Optional headset: KX-TCA60, KX-TCA93, KX-TCA400, KX-TCA430
- Optional T-adaptor: KX-J66
- Optional Range extender: KX-TGA405

4 Technical Descriptions

4.1. US-DECT Description

The frequency range of 1.92 GHz-1.93 GHz is used. Transmitting and receiving carrier between base unit and Portable is same frequency. Refer to **Frequency Table** (P.58).

4.1.1. TDD Frame Format

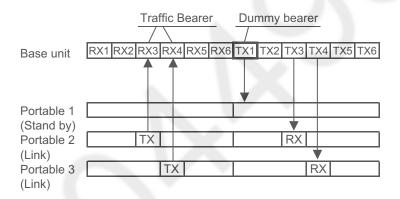


4.1.2. TDMA system

This system is the cycles of 10 ms, and has 6 duplex paths, but maximum duplex communication path is 5 because of dummy bearer use.

In 1 slot 417 μ s, the 10 ms of voice data is transmitted.

• 2 - Portables Link



Traffic Bearer

A link is established between base unit and Portable.

The state where duplex communication is performed.

Portable doesn't make up duplex in no free RF channels because of interference. (*1)

Dummy Bearer

Base unit sends Dummy-data to the all stand-by state portables.

Portables receive that data for synchronization and monitoring request from the base unit.

Base unit doesn't send Dummy bearer in no free RF channels because of interference. (*1)

Note:

(*1) It is a feature under FCC 15 regulation and for interference avoidance.

In the case of checking RF parts, it is better in least interference condition.

KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

4.1.3. Signal Flowchart in the Radio Parts

Reception

Base unit:

A voice signal from TEL line is encoded to digital data and converted into a 1.9 GHz modulated radio signal by BBIC(IC501). The RF signal, after which is amplified in BBIC, is fed to selected antenna.

Portable:

As for a portable RF, RF signal is received in one antenna.

BBIC down-converts to 864 kHz IF signal from RX signal and demodulates it to digital data "RXDATA".

BBIC (IC1) converts RXDATA into a voice signal and outputs it to speaker.

Transmission

Portable:

A voice signal from microphone is encoded to digital data and converted into a 1.9 GHz modulated radio signal by BBIC(IC1). The RF signal, after which is amplified in BBIC, is fed to an antenna.

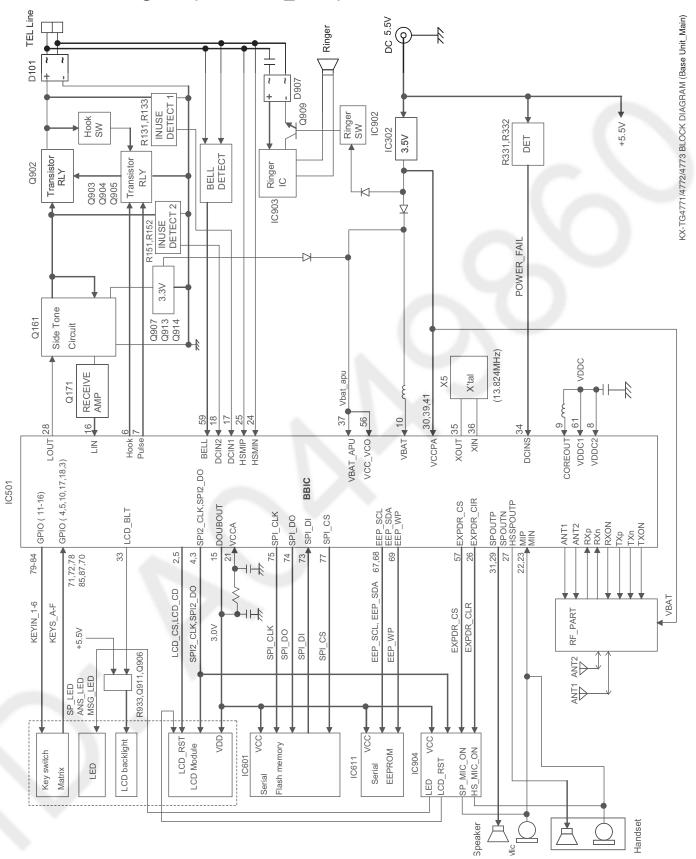
Base unit:

As for a base unit RF, RF signal is received in two antennas.

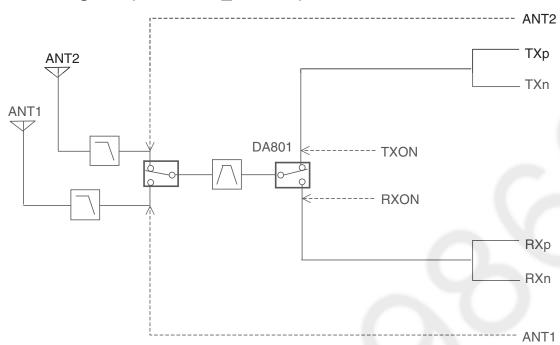
BBIC (IC501) compares RF signal levels and selects the antenna to be used. Then BBIC down-converts to 864 kHz IF signal from RX signal in the selected antenna, and demodulates it to digital data "RXDATA".

BBIC (IC501) converts RXDATA into a voice signal and outputs it to TEL line.

4.2. Block Diagram (Base Unit_Main)



4.3. Block Diagram (Base Unit_RF Part)



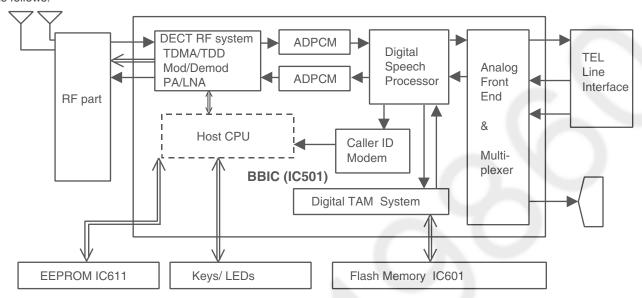
KX-TG4771/4772/4773 BLOCK DIAGRAM (Base Unit_RF Part)

4.4. Circuit Operation (Base Unit)

General Description:

(BBIC, Flash Memory, EERROM) is a digital speech/signal processing system that implements all the functions of speech compression, record and playback, and memory management required in a digital telephone answering machine.

The BBIC system is fully controlled by a host processor. The host processor provides activation and control of all that functions as follows.



4.4.1. BBIC (Base Band IC: IC501)

Voice Message Recording/Play back

The BBIC system uses a proprietary speech compression technique to record and store voice message in Flash Memory. An error correction algorithm is used to enable playback of these messages from the Flash Memory.

DTMF Generator

When the DTMF data from the portable is received, the DTMF signal is output.

Synthesized Voice (Pre-recorded message)

The BBIC implements synthesized Voice, utilizing the built in speech detector and a Flash Memory, which stored the vocabulary.

Caller ID demodulation

The BBIC implements monitor and demodulate the FSK/DTMF signals that provide CID information from the Central Office.

Digital Switching

The voice signal from telephone line is transmitted to the portable or the voice signal from the portable is transmitted to the Telephone line, etc. They are determined by the signal path route operation of voice signal.

Block Interface Circuit

RF part, LED, Key scan, Speaker, Telephone line.

4.4.2. Flash Memory (IC601)

Following information data is stored.

Voice signal

ex: Pre-recorded Greeting message, Incoming message

4.4.3. **EEPROM (IC611)**

Following information data is stored.

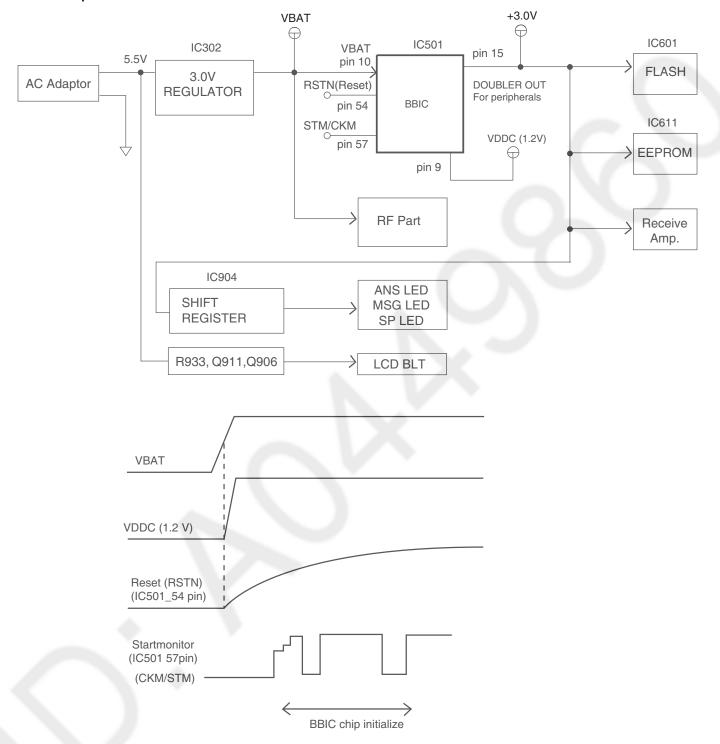
Settings

ex: message numbers, ID code, Flash Time, Tone/Pulse

4.4.4. Power Supply Circuit/Reset Circuit

The power supply voltage from AC adaptor is converted to VBAT (3.0 V) in IC302. And +3.0V for peripherals and analog part is insulated from VBAT by Doubler of BBIC.

Circuit Operation:



4.4.5. Telephone Line Interface

Telephone Line Interface Circuit:

Function

- · Bell signal detection
- · ON/OFF hook and pulse dial circuit
- · Side tone circuit

Bell signal detection and OFF HOOK circuit:

In the idle mode, Q141 is open to cut the DC loop current and decrease the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

 $T \rightarrow R111 \rightarrow C111 \rightarrow Q111 \rightarrow BBIC pin 59$

When the CPU (BBIC) detects a ring signal, Q141 turns on, thus providing an off-hook condition (active DC current flow through the circuit). Following signal flow is the DC current flow.

 $T \rightarrow D101 \rightarrow Q902 \rightarrow Q161 \rightarrow R163 \rightarrow R167 \rightarrow D908 \rightarrow D909 \rightarrow Q913 \rightarrow D101 \rightarrow P101 \rightarrow R100 \rightarrow R10$

ON HOOK Circuit:

Q902 is open, Q902 is connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in an on-hook condition.

Pulse Dial Circuit:

Pin 6 of BBIC turns Q902 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal. As for this unit, TX signal feed back from Q161 is canceled by the canceller circuit of BBIC.

4.4.6. Parallel Connection Detect Circuit/Auto Disconnect Circuit

Function:

In order to disable call waiting and stutter tone functions when using telephones connected in parallel, it is necessary to have a circuit that judges whether a telephone connected in parallel is in use or not. This circuit determines whether the telephone connected in parallel is on hook or off hook by detecting changes in the T/R voltage.

Circuit Operation:

Parallel connection detection when on hook:

When on hook, the voltage is monitored at pin 17 of IC501. There is no parallel connection if the voltage is 0.54 V or higher, while a parallel connection is deemed to exist if the voltage is lower.

Parallel connection detection when off hook:

When off hook, the voltage is monitored at pin 18 of IC501; the presence/absence of a parallel connection is determined by detecting the voltage changes.

If the Auto disconnect function is ON and statuses are Hold, receiving ICM, OGM transmitting, BBIC disconnects the line after detecting parallel connection is off hook.

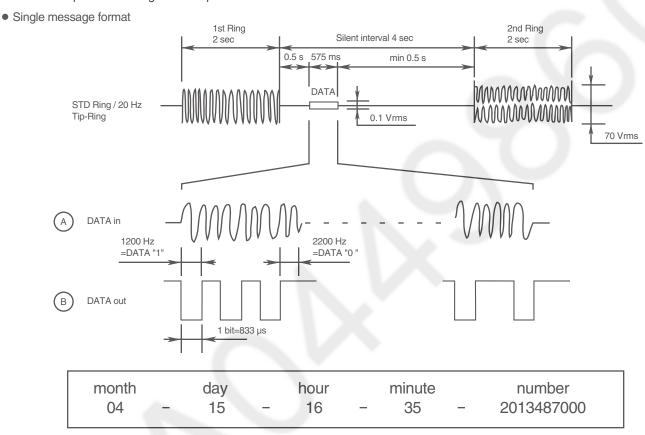
4.4.7. Calling Line Identification (Caller ID)/Call Waiting Caller ID

Function:

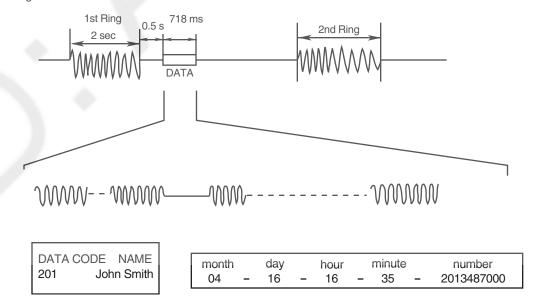
Caller ID

The caller ID is a chargeable ID which the user of a telephone circuit obtains by entering a contract with the telephone company to utilize a caller ID service. For this reason, the operation of this circuit assumes that a caller ID service contract has been entered for the circuit being used. The data for the caller ID from the telephone exchange is sent during the interval between the first and second rings of the bell signal. The data from the telephone exchange is a modem signal which is modulated in an FSK (Frequency Shift Keying) * format. Data "1" is a 1200 Hz sine wave, and data "0" is a 2200 Hz sine wave. There are two types of the message format which can be received: i.e. the single message format and plural message format. The plural message format allows to transmit the name and data code information in addition to the time and telephone number data.

*: Also the telephone exchange service provides other formats.



Plural message format



Call Waiting Caller ID

Calling Identity Delivery on Call Waiting (CIDCW) is a CLASS service that allows a customer, while off-hook on an existing call, to receive information about a calling party on a waited call. The transmission of the calling information takes place almost immediately after the customer is alerted to the new call so he/she can use this information to decide whether to take the new call.

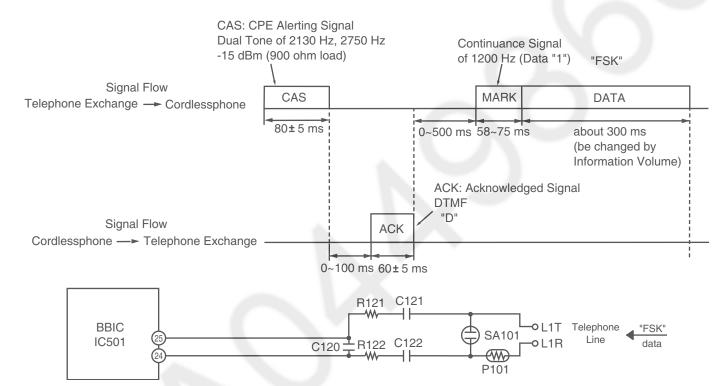
Function:

The telephone exchange transmits or receives CAS and ACK signals through each voice RX/TX route. Then FSK data and MARK data pass the following route.

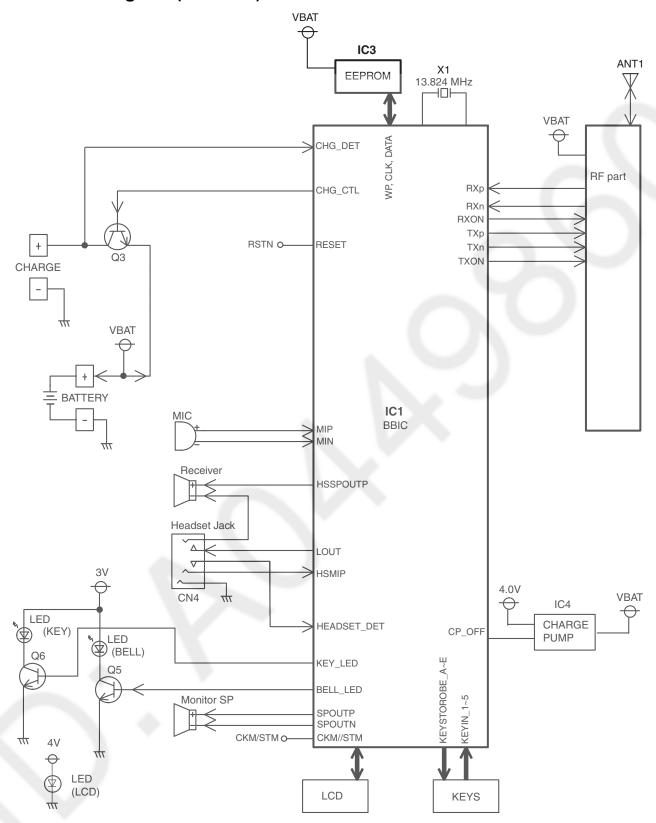
Telephone Line \rightarrow P101 \rightarrow C121, C122 \rightarrow R121, R122 \rightarrow IC501 (25, 24).

If the unit deems that a telephone connected in parallel is in use, ACK is not returned even if CAS is received, and the information for the second and subsequent callers is not displayed on the portable display.

Call Waiting Format

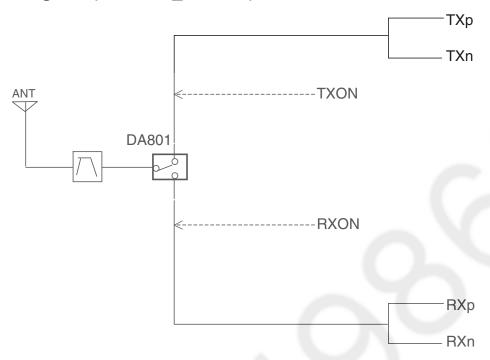


4.5. Block Diagram (Portable)



KX-TGA470 BLOCK DIAGRAM (Portable)

4.6. Block Diagram (Portable_RF Part)



KX-TGA470 BLOCK DIAGRAM (Portable_RF Part)

4.7. Circuit Operation (Portable)

4.7.1. **Outline**

Portable consists of the following ICs as shown in Block Diagram (Portable) (P.16).

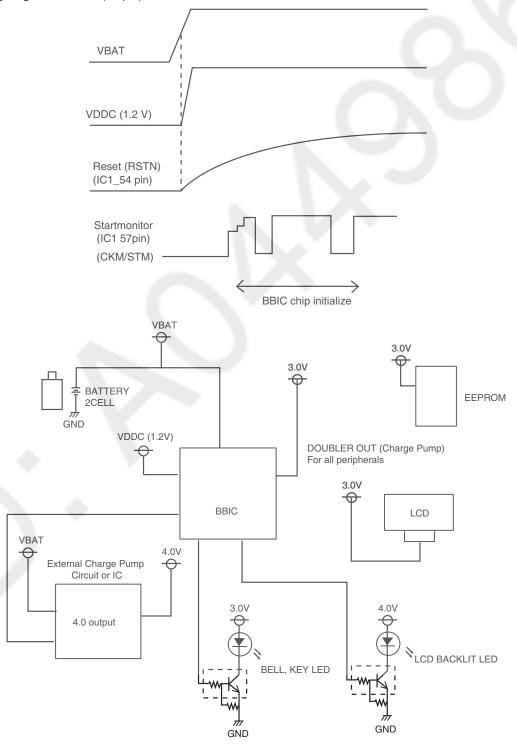
- DECT BBIC (Base Band IC): IC1
 - All data signals (forming/analyzing ACK or CMD signal)
 - All interfaces (ex: Key, Detector Circuit, Charge, EEPROM, LCD)
- EEPROM: IC3
 - Setting data is stored. (e.g. ID, user setting)

4.7.2. Power Supply Circuit/Reset Circuit

Circuit Operation:

When power on the Portable, the voltage is as follows; BATTERY(2.2 V ~ 2.6 V: BATT+) \rightarrow F1 \rightarrow BBC1 (IC1) 10 pin

The Reset signal generates IC1 (54 pin) and 1.8 V.



4.7.3. Charge Circuit

Circuit Operation:

When charging the Portable on the Base Unit, the charge current is as follows;

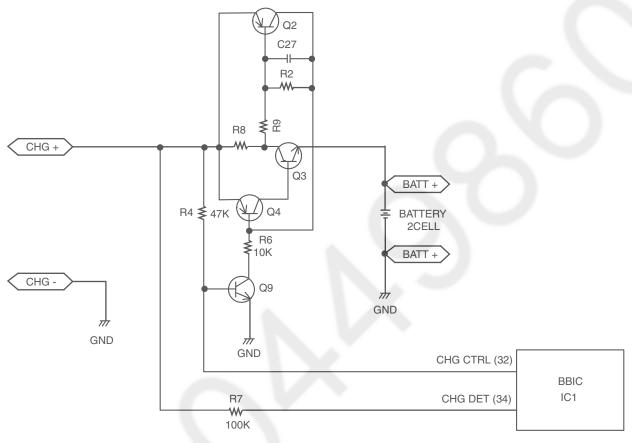
 $\mathsf{DC+}(6.5\ \mathsf{V}) \to \mathsf{F301} \to \mathsf{R371} \to \mathsf{R372} \to \mathsf{CHARGE+}(\mathsf{Base}) \to \mathsf{CHARGE+}(\mathsf{Portable}) \to \mathsf{Q3} \to \mathsf{F1} \to \mathsf{BATTERY+}...\ \mathsf{Battery}...$

BATTERY- \rightarrow R45 \rightarrow GND \rightarrow CHARGE-(Portable) \rightarrow CHARGE-(Base) \rightarrow GND \rightarrow DC-(GND)

In this way, the BBIC on Portable detects the fact that the battery is charged.

The charge current is controlled by switching Q9 of Portable.

Refer to Fig.101 in Power Supply Circuit/Reset Circuit (P.12).



4.7.4. Battery Low/Power Down Detector

Circuit Operation:

"Battery Low" and "Power Down" are detected by BBIC which check the voltage from battery.

The detected voltage is as follows;

· Battery Low

Battery voltage: V(Batt) ≤ 2.35 V ± 100 mV

The BBIC detects this level and " starts flashing.

• Power Down

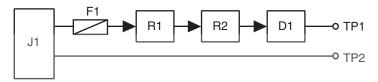
Battery voltage: $V(Batt) \le 2.1 \text{ V} \pm 50 \text{ mV}$ The BBIC detects this level and power down.

4.7.5. Speakerphone

The hands-free loudspeaker at SP+ and SP- is used to generate the ring alarm.

4.8. Circuit Operation (Charger Unit)

Charge control is executed at Portable side so that the operation when using charger is also controlled by Portable. Refer to **Circuit Operation (Portable)** (P.18)



AC Adaptor

The route for this is as follows: DC+pin of J1(+) \rightarrow F1 \rightarrow R1 \rightarrow R2 \rightarrow D1 \rightarrow CHARGE+pad \rightarrow Portable \rightarrow CHARGE-pad \rightarrow DC-pin of J1(-).

4.9. Signal Route

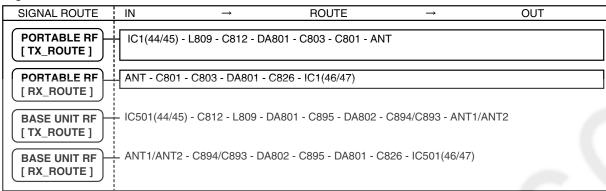
SIGNAL ROUTE	IN	\rightarrow	ROUTE	\rightarrow	OUT
PORTABLE TX-	PORTABLE MIC - F		' '		
	ANT BASE_U ANT [P101] - T/I	NIT_RF_RX_R	ANT DUTE> - IC501(46/47	7 - 28) - C184 - C	Q161 - Q902
PORTABLE RX	T/R(TEL LINE) - [P1		902 - R165 - C173 - C _ RF_TX_ROUTE>		178
		BLE_RF_RX_R	OUTE> - IC1(28/27) -		
PORTABLE TX-	`	•	R22 - IC1(25) - <po< b=""> DUTE> - IC501(46/47</po<>		X_ROUTE> - ANT
	- D101 - [P101] - T/I		301L 2 10301(40/47	20) 0104 0	2101 Q302
PORTABLE RX		- <base_unit< td=""><td>_RF_TX_ROUTE> -</td><td>ANT</td><td></td></base_unit<>	_RF_TX_ROUTE> -	ANT	
	ANT <portae< b=""></portae<>	BLE_RF_RX_R	DUTE> - IC1(28) - C1	16 - L8 - HEADS	ET_JACK(5)
PORTABLE ————————————————————————————————————	PORTABLE MIC - F				
	ANT <base_u< b=""> - D101 - [P101] -T/F</base_u<>		OUTE> - IC501(46/47	7 - 28) - C184 - C	Q161 - Q902
PORTABLE SP-Phone RX		<base_unit_< th=""><th>RF_TX_ROUTE> - A</th><th>NT</th><th>78</th></base_unit_<>	RF_TX_ROUTE> - A	NT	78
BASE			DUTE> - IC1(29/31) -		
HANDSET TX BASE	MIC - C457/C458 - - D101 - [P101] - T/I		3/22-28) - C184 - Q1	61 - Q902	
HANDSET RX	 T/R(TEL LINE) - [P⁻ - IC501(16-27/GND 		902 - Q161 - C173 - (Q171 - C178 - R	178
BASE ————————————————————————————————————	MIC - C918/C919 - I - D101 - [P101] - T/F		23/22 - 28) - C184 - C	Q161 - Q902 -	
BASE ————————————————————————————————————	T/R(TEL LINE) - [P1 - IC501 (16 - 29/31)		902 - R165 - C173 - C)171 - C178 - R1	178
INTERCOM ————————————————————————————————————	PORTABLE MIC - F		' '		
BASE UNIT INTERCOM ———			ROUTE> - IC501(46/4 C918&919 - R945/R9	,	
BASE UNIT TO PORTABLE	<base_unit_rf_< th=""><th></th><th></th><th>40 - 10301 (23/22</th><th></th></base_unit_rf_<>			40 - 10301 (23/22	
TOTOTTABLE			ROUTE> - IC1(28/27) PORTABLE SPEAKE		
GREETING	PORTABLE MIC - F				
	i		OUTE> - IC501(46/4	,	I
GREETING PLAY — TO TEL LINE	L IC601 - IC501(73/74 - T/R(TEL LINE)	1 - 28) - C184 -	Q161 - Q902 - D101	-[P101]	
ICM RECORDING -	T/R(TEL LINE) - [P - IC501(16 - 73/74)		902 - R165 - C173 - (Q171 - C178 - R	178
SPEAKER	- IC601 - IC501(73/74	,			
TO TEL LINE	– IC501(28) - C184 -				
	– T/R(TEL LINE) - [P				
BELL DETECTION -	T/R(TEL LINE) - [P	101] - R111/R1	I2 - C111/C112 - Q11	I1 - IC501(59)	

Note:

: inside of Portable

KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

RF part signal route



Note:

: inside of Portable

5 Location of Controls and Components

Refer to the Operating Instructions.

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

6 Installation Instructions

Refer to the Operating Instructions.

Note

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

7 Operating Instructions

Refer to the Operating Instructions.

Note

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

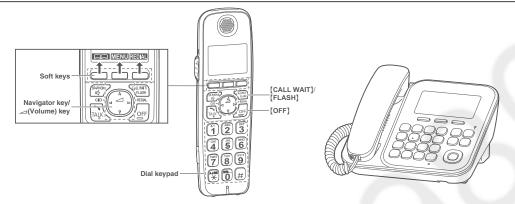
8 Test Mode

8.1. Engineering Mode

8.1.1. Base Unit

Important:

Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



H/S key operation

- 1). Press MENU .
- 2). Select "Initial Setting" using [▲] or [▼] then press <code>ṢELET</code> or [►].

Select "Set tel line" using [▲] or [▼] then press SELECT or [►].

- 3). Enter "7", "2", "6", "2", "7", "6", "6", "4".

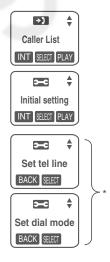
 Note: 7262 7664 = PANA SONI

 (see letters printed on dial keys)
- 4). Select "Write EEP" using (▲) or (▼) then press SECT or (►).
- 5). Enter "●", "●", "●", "●" (Address). (*1)
- 6). Enter "*", "*" (New Data). (*1)
- 7). Press **OK** , a long confirmation beep will be heard.
- 8). Press [OFF] to return to standby mode.

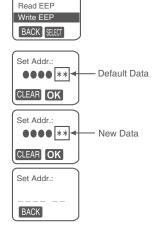
 After that, turn the base unit power off and then power on.

After that, turn the base unit power off and t

H/S LCD



Service Mode



Note: * To enter "Set dial mode", press [IEEF] or [>] at " Set tel line". It is necessary to turn on the power of base unit.

Frequently Used Items (Base Unit)

Items	Address	Default Data	New	Data	Remarks
Frequency	00 07 / 00 08	00/01	-	-	Use these items in a READ-ONLY mode to
ID	00 02 ~ 00 06	Given value	-	-	confirm the contents. Careless rewriting may
					cause serious damage to the computer system.

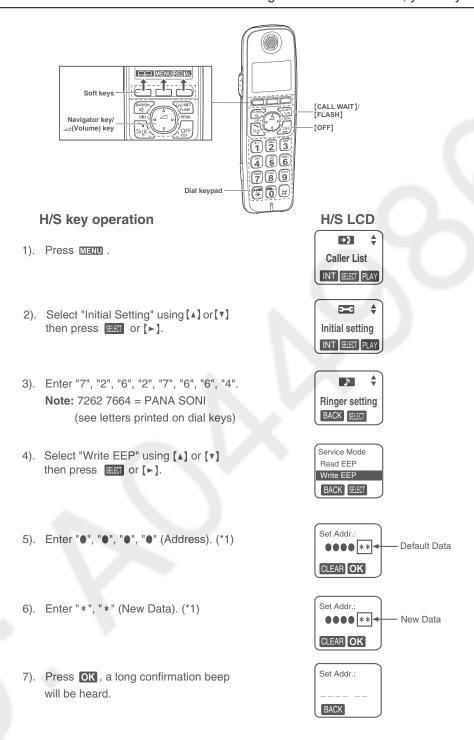
Note: (*1) When you enter the address or New Data, please refer to the table below.

Desired Number (hex)	Input Keys	Desired Number (hex)	Input Keys
0	0	A	[Flash] + 0
1	1	В	[Flash] + 1
		С	[Flash] + 2
		D	[Flash] + 3
		E	[Flash] + 4
9	9	F	[Flash] + 5

8.1.2. Portable

Important:

Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



8). Press [OFF] to return to standby mode.
After that, remove and reinsert the batteries. Press the Power button for about 1 second if the power is not turned on.

Frequently Used Items (Portable)

ex.)

Items	Address	Default Data	New Data	Possible Adjusted Value MAX (hex)	Possible Adjusted Value MIN (hex)	Remarks
Battery Low	00 12/00 13	00 / 00	-	-	-	
Frequency	00 07 / 00 08	00 / 01	-	-	-	(*2)
ID	00 02 ~ 00 06	Given value	-	-	-	

Note:

(*1) When you enter the address or New Data, please refer to the table below.

Desired Number (hex.)	Input Keys	Desired Number (hex.)	Input Keys
0	0	A	[Flash] + 0
1	1	В	[Flash] + 1
·		С	[Flash] + 2
		D	[Flash] + 3
		E	[Flash] + 4
9	9	F	[Flash] + 5

^(*2) Use these items in a READ-ONLY mode to confirm the contents. Careless rewriting may cause serious damage to the Portable.

9 Service Mode

9.1. How to Clear User Setting (Portable Only)

Portable

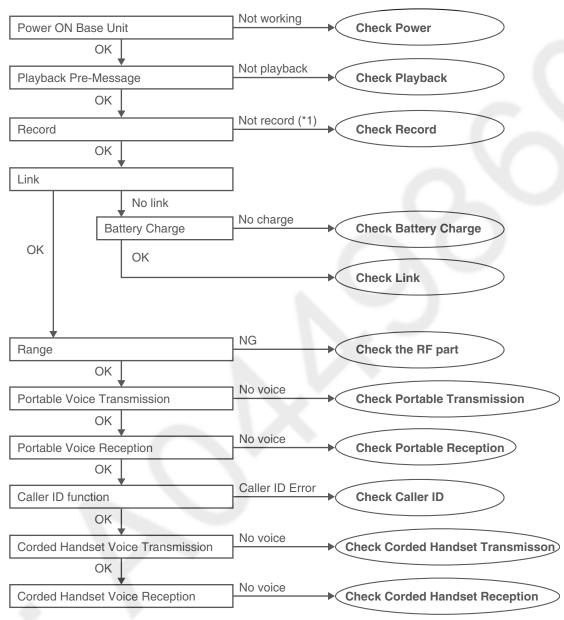
Press 2, 5, 8, 0 simultaneously until a beep sound is heard. Then single portable is initialized. (The contents of user setting are reset to factory default)

*Usage time is not cleared.

10 Troubleshooting Guide

10.1. Troubleshooting Flowchart

FLOW CHART



Cross Reference:

Check Power (P.30)

Check Playback (P.34)

Check Record (P.31)

Check Battery Charge (P.34)

Check Link (P.35)

Check the RF part (P.37)

Check Portable Transmission (P.42)

Check Portable Reception (P.42)

Check Caller ID (P.42)

Check SP-phone Transmission (P.42)

Check SP-phone Reception (P.42)

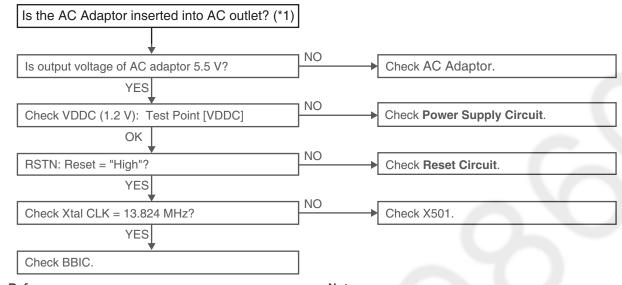
Note:

(*1) When a user claims that the unit disconnects a call right after the greeting message and no incoming messages can be recorded, this symptom can not be reappeared with TEL simulator in the service center. In this case, try to change the Auto disconnect activation time and Vox level.

<How to change the Auto Disconnect activation time and VOX level> (P.32) item (A) and (B).

10.1.1. Check Power

10.1.1.1. Base Unit



Cross Reference:

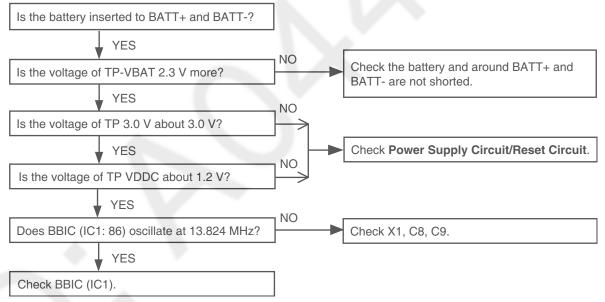
Power Supply Circuit/Reset Circuit (P.12)

Note:

BBIC is IC501.

- (*1) Refer to **Specifications** (P.6) for part number and supply voltage of AC adaptor.
- (*2) Refer to Base Unit (Main) (P.75).

10.1.1.2. Portable



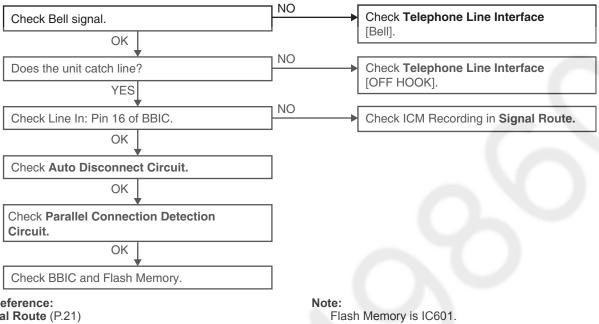
Cross Reference:

Power Supply Circuit/Reset Circuit (P.18)

10.1.2. Check Record

10.1.2.1. Base Unit

Not record Incoming Message



Cross Reference:

Signal Route (P.21)

Telephone Line Interface (P.13)

Parallel Connection Detect Circuit/Auto Disconnect Circuit (P.13)

BBIC is IC501.

<How to change the Auto Disconnect activation time and VOX level>

A) Auto Disconnect activation time:

Some Telephone Company lines (fiber or cable) ON Hook and OFF Hook voltages are lower than conventional lines, which may cause a malfunction of Auto Disconnect detection. To solve this problem, try changing the Auto Disconnect activation through the procedures below.

1) Press "MENU" key at standby Mode and "#" key.

LCD (H/S)



Note: The set must power on and be linked.

2) Press "9", "0", "0", "0"," *".

LCD (H/S)

```
Service ready:———
```

3) Press "7", "3", "1".

4) Then enter the below last digit;

last digit	"0"	Auto disconnect & CPC : enable [default]
*	"1"	Auto disconnect : enable ^(*1) CPC : disable
\ '	"2"	Auto disconnect & CPC : disable (*2)

Note:

- (*1) Both Auto Disconnect and CPC don't detect for the first 2 seconds.
- (*2) If the "Disable" is selected, even if the parallel-connected telephone is OFF HOOK, the line isn't disconnected.
- 5) Back to "standby" mode automatically after step 4). You can hear beep sound which is a confirmation tone.

B) Vox level:

It makes easier to detect a small voice (caller) by raising the sensitivity of VOX level. Therefore, the recording of TAM is not turned off during a detection.

- 1) ~ 2) are same as (A).
- 3) Press "5","1","1".



4) Then enter the below last digit;

last digit	"0"	default setting : normal
	"1"	6dB up

5) Back to "standby" mode automatically after step 4). You can hear beep sound which is a confirmation tone.

10.1.3. Check Playback

10.1.3.1. Base Unit

Note:

- (*1) Both Auto Disconnect and CPC don't detect for the first 2 seconds.
- (*2) If the "Disable" is selected, even if the parallel-connected telephone is OFF HOOK, the line isn't disconnected.
- 5) Back to "standby" mode automatically after step 4). You can hear beep sound which is a confirmation tone.

Cross Reference: Power Supply Circuit/Reset Circuit (P.12)

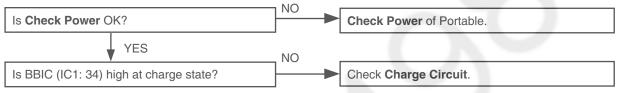
(*1) Refer to Base Unit (Main) (P.75).

Flash Memory is IC601.

BBIC is IC1.

10.1.4. Check Battery Charge

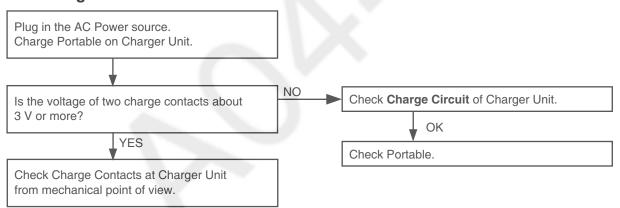
10.1.4.1. Portable



Cross Reference:

Check Power (P.30)
Charge Circuit (P.19)

10.1.4.2. Charger Unit

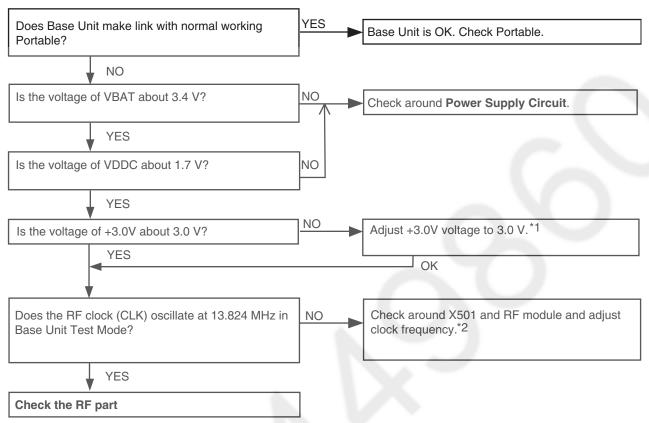


Cross Reference:

Charge Circuit (P.19)

10.1.5. Check Link

10.1.5.1. Base Unit



Cross Reference:

Power Supply Circuit/Reset Circuit (P.12)

Check the RF part (P.37)

Note:

*1 How to adjust +3.0V:

Execute the command "VDA"

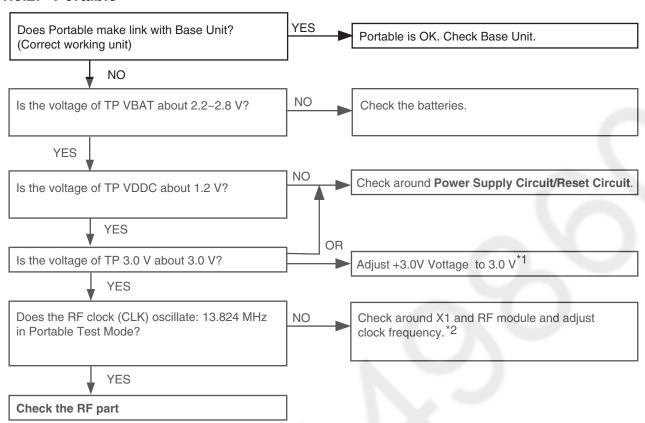
Refer to Things to Do after Replacing IC or X'tal (P.56) for Base Unit.

*2 How to adjust the frequency of X501:

To see the frequency, execute the command "SFR", then check the TP_CKM (IC501-57pin).

To adjust frequency, send command "SFR —OO—OO" until the frequency counter becomes 13.824 MHZ ± 83HZ.

10.1.5.2. Portable



Cross Reference:

Power Supply Circuit/Reset Circuit (P.18)

Check the RF part (P.37)

Note:

*1 How to adjust +3.0V:

Execute the command "VDA"

Refer to Things to Do after Replacing IC or X'tal (P.57) for Portable.

*2 How to adjust the frequency of X1:

To see the frequency, execute the command "SFR", then check the TP_CKM (IC1-57pin).

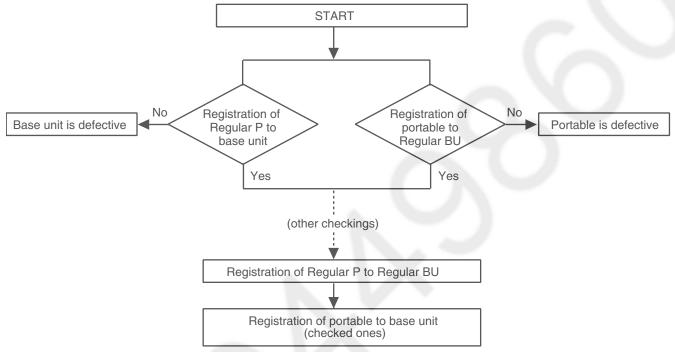
10.1.6. Check the RF part

10.1.6.1. Finding out the Defective part

- 1. Prepare Regular P (*1) and Regular BU(*2).
- 2. a. Re-register regular P (Normal mode) to base unit (to be checked). If this operation fails in some ways, the base unit is defective.
 - b. Re-register portable (to be checked) to regular BU (Normal mode). If this operation fails in some ways, the portable is defective.

After All the Checkings or Repairing

1. Re-register the checked portable to the checked base unit, and Regular P to Regular BU.

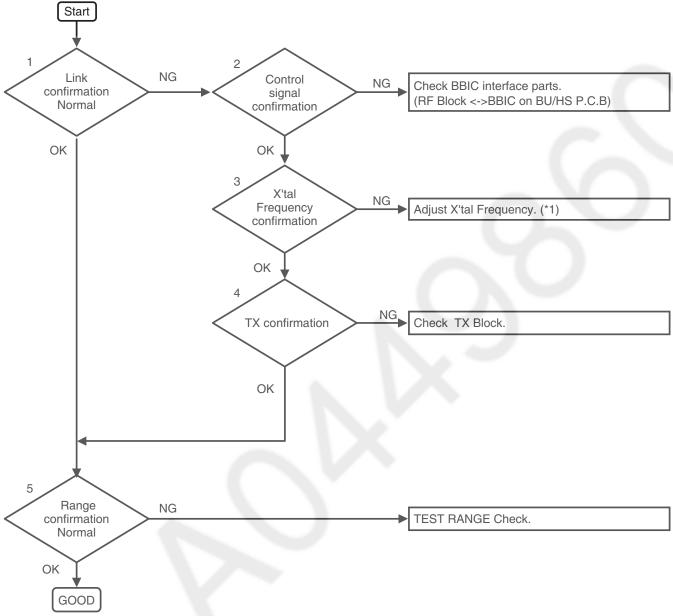


Note:

(*1) P: Portable (*2) BU: Base Unit

10.1.6.2. RF Check Flowchart

Each item (1 \sim 5) of RF Check Flowchart corresponds to **Check Table for RF part** (P.39). Please refer to the each item.



Note:

(*1) Refer to Check Link (P.35).

10.1.6.3. Check Table for RF part

No.	ltem	BU (Base Unit) Check	P (Portable) Check
1	Link Confirmation Normal	Register Regular P to BU (to be checked). Press [Talk] key of the Regular P to	Register P (to be checked) to Regular BU. Press [Talk] key of the P to establish link.
	P, BU Mode [Normal Mode]	establish link.	
2	X'tal Frequency confirmation	Check X'tal Frequency.	Check X'tal Frequency.
		(13.824000 MHz ± 83 Hz)	(13.824000 MHz ± 83 Hz)
	P, BU Mode: [Adjustment]		
3	TX confirmation	Remove wire antenna 2 and connect spectrum analyzer to TP. (*3)	Connect spectrum analyzer to TP.(*4) Confirm TX power whether satisfied spec.
	P Mode:	Confirm TX power whether spec. is	Power = 16.0 dBm ~ 25.0 dBm
	[P_Burst Mode] (*1)	satisfied.	
	BS Mode:	Power = 16.0 dBm ~ 20.5 dBm	
	[BS_Burst Mode] (*2)		
4	Range Confirmation Normal	Register Regular P to BU (to be checked). Press [Talk] key of the Regular P to	Register P (to be checked) to Regular BU. Press [Talk] key of the P to establish link.
	P, BU Mode: [Normal Mode]	establish link. 3. Compare the range of the BU (being checked) with that of the Regular BU.	Compare the range of the P (being checked) with that of the Regular HS.

Note:

- (*1) Refer to **Commands (Portable)** (P.52)
- (*2) Refer to **Commands (Base Unit)** (P.52)
- (*3) Adjustment Standard (Base Unit) (P.53)
- (*4) Adjustment Standard (Portable) (P.55)

10.1.6.4. TEST RANGE Check

Circuit block which range is defective can be found by the following check.

Item	BU (Base Unit) Check	P (Portable) Check
Range Confirmation TX TEST	Register Regular P to BU (to be checked).	Register P (to be checked) to Regular BU.
(TX Power check)		
	Set TX Power of the BU and the Regular P	Set TX Power of the P and the Regular BU
P, BU setting	according to CHART1.	according to CHART1.
Checked unit: Low TX power (*1)		
Regular unit: High TX power (*1)	3. At distance of about 20m between P and BU,	At distance of about 20m between P and BU,
	Link OK = TX Power of the BU is OK.	Link OK = TX Power of the P is OK.
	No Link = TX Power of the BU is NG.	No Link = TX Power of the P is NG.
Range Confirmation RX TEST	Register Regular P to BU (to be checked).	Register P (to be checked) to Regular BU.
(RX sensitivity check)		
	Set TX Power of the BU and the Regular P	Set TX Power of the Checking P and the
P, BU setting	according to CHART1.	Regular BU according to CHART1.
Checked unit: High TX power (*1)		
Regular unit: Low TX power (*1)	3. At distance of about 20m between P and BU,	3. At distance of about 20m between P and BU,
	Link OK= RX Sensitivity of the BU is OK.	Link OK= RX Sensitivity of the P is OK.
	No Link = RX Sensitivity of the BU is NG.	No Link = RX Sensitivity of the P is NG

CHART1: Setting of TX Power and RX Sensitivity in Range Confirmation TX TEST, RX TEST

	BU (to be checked)	Regular_P
	TX Power	TX Power
BU (Base Unit) TX Power Check	Low	High
BU (Base Unit) RX Sensitivity Check	High	Low

	P (to be checked)	Regular_BU
	TX Power	TX Power
P (portable) TX Power Check	Low	High
P (portable) RX Sensitivity Check	High	Low

Note:

(*1) Refer to Commands (Base Unit) (P.52).

10.1.7. Registering a Portable to the Base Unit

The supplied portable and base unit are pre-registered. If for some reason the portable is not registered to the base unit, re-register the portable.

1 Portable:

(MENU) # 1 3 0

2 Base unit:

Press and hold **[LOCATOR]** for about 5 seconds until the registration tone sounds.

- If all registered portables start ringing, press [LOCATOR] again to stop, then repeat this step.
- The next step must be completed within 90 seconds.

3 Portable:

Press [OK], then wait until a long beep sounds.

Note:

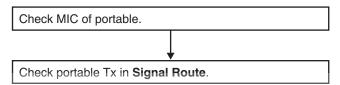
- While registering, "Base in registering" is displayed on all registered portables.
- When you purchase an additional portable, referto the additional portable's installation manual for registration.

10.1.8. Deregistering a Portable

A portable can cancel its own registration to the base unit, or other portables registered to the same base unit. This allows the portable to end its wireless connection with the system.

- 1 [MENU] # 1 3 1
 - All portables registered to the base unit are displayed.
- 2 $\{ \}$: Select the portable you want to cancel. $\rightarrow \{ \}$
- 3 (\updownarrow): "Yes" \rightarrow [SELECT]
- 4 [OFF]

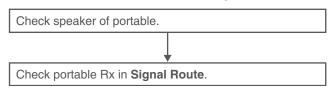
10.1.9. Check Portable Transmission



Cross Reference:

Signal Route (P.21)

10.1.10. Check Portable Reception



Cross Reference:

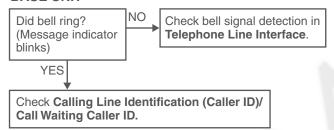
Signal Route (P.21)

Note:

When checking the RF part, Refer to **Check the RF part** (P.37).

10.1.11. Check Caller ID

BASE UNIT



Cross Reference:

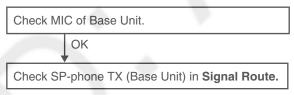
Telephone Line Interface (P.13)

Calling Line Identification (Caller ID)/Call Waiting Caller ID (P.14)

Note:

- Make sure the format of the Caller ID service of the Telephone company that the customer subscribes to.
- It is also recommended to confirm that the customer is really a subscriber of the service.

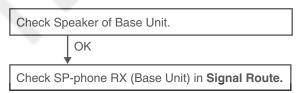
10.1.12. Check SP-phone Transmission



Cross Reference:

Signal Route (P.21)

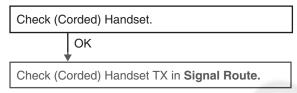
10.1.13. Check SP-phone Reception



Cross Reference:

Signal Route (P.21)

10.1.14. Check Corded Handset Transmission



Cross Reference:

Signal Route (P.21)

10.1.15. Check Corded Handset Reception



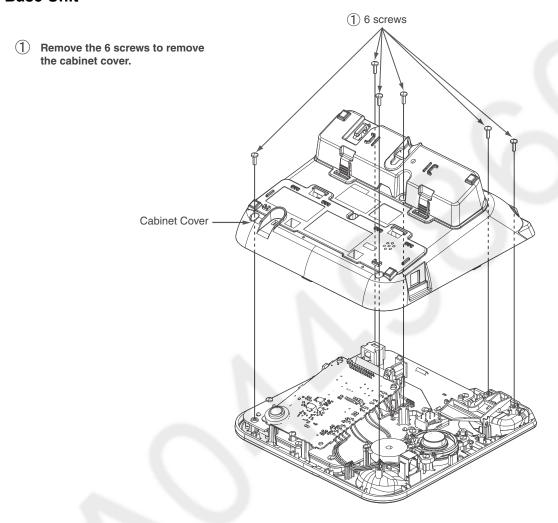
Cross Reference:

Signal Route (P.21)

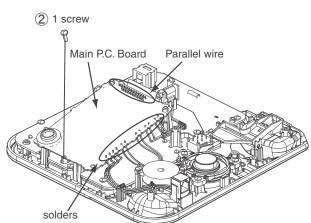
11 Disassembly and Assembly Instructions

11.1. Disassembly Instructions

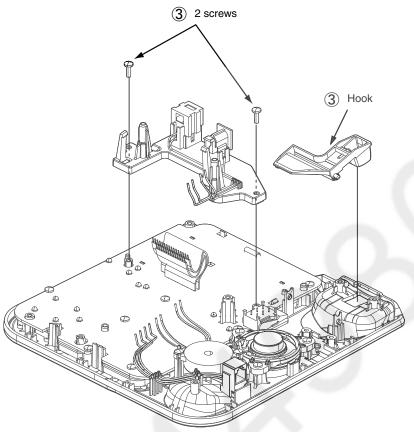
11.1.1. Base Unit

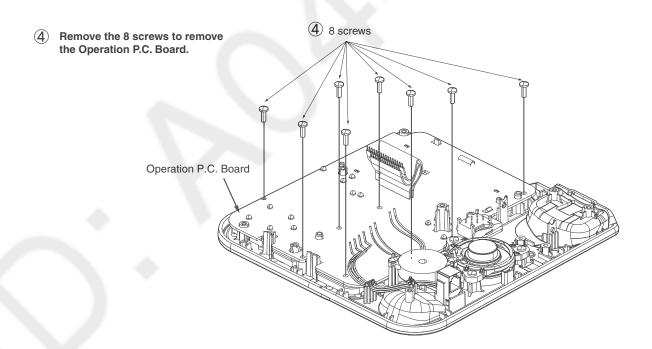


2 Remove 1 screw, Parallel wire and solders to remove the main P.C. Board.



3 Unhook the hook and remove the 2 screws to remove the jack holder.



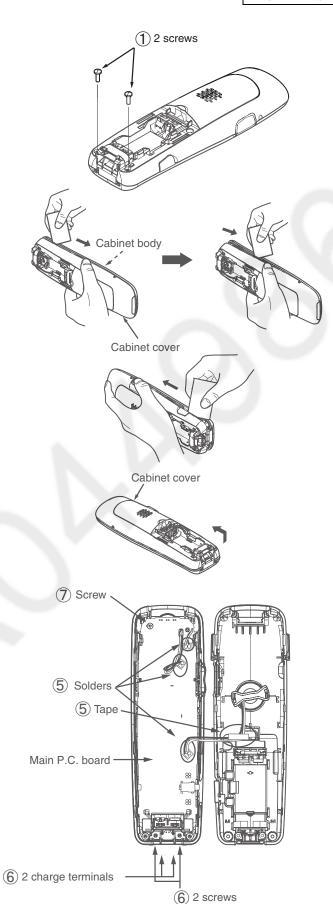


11.1.2. Portable

1 Remove the 2 screws.

- ② Insert a plastic card. (Ex. Used SIM card etc.) between the cabinet body and the cabinet cover, then pull it along the gap to open the cabinet.
- 3 Likewise, open the other side of the cabinet.
- 4 Remove the cabinet cover by pushing it upward.

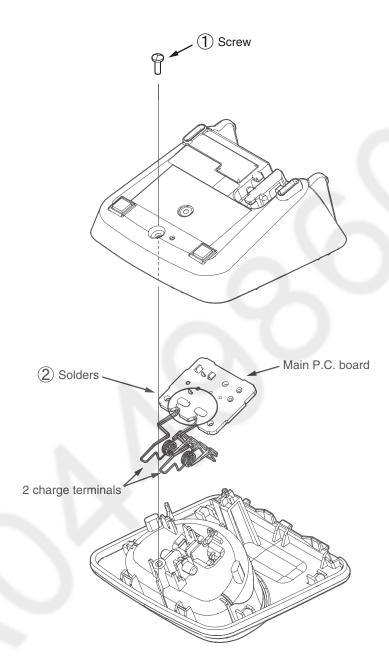
- (5) Remove the solders and tape.
- 6 Remove the 2 screws to remove the 2 charge terminals.
- Remove the screw to remove the main P. C. board.



11.1.3. Charger Unit

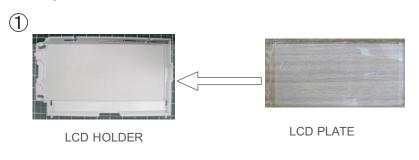
1 Remove the screw to remove the cabinet cover.

② Remove the solders to remove the 2 charge terminals.



11.2. Assembly Instructions

11.2.1. How to Replace the Base unit LCD

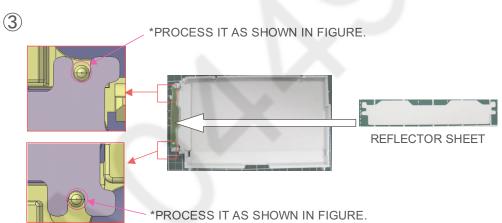


*PROCESS IT AS SHOWN IN FIGURE.

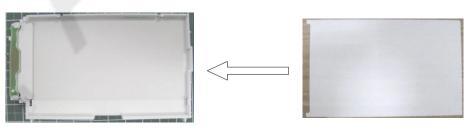


REVERSE.

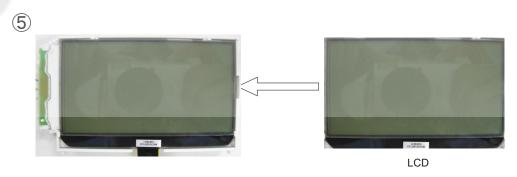
LED P.C.B.







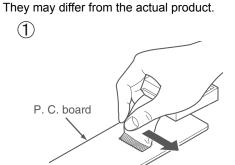
DIFFUSION SHEET



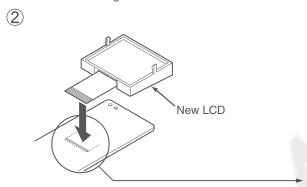
11.3. How to Replace the Portable LCD

Note:

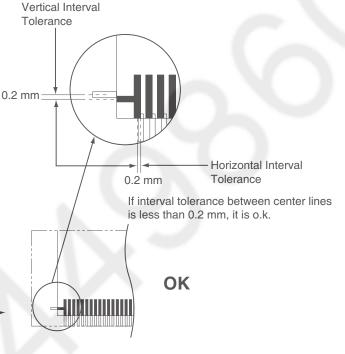
The illustrations are simplified in this page.

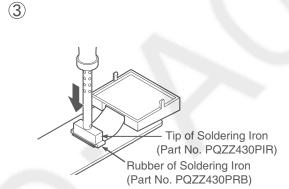


Peel off the FFC (Flexible Flat Cable) from the LCD, in the direction of the arrow. Take care to ensure that the foil on the P.C. board is not damaged.

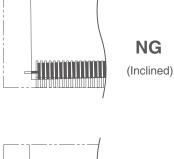


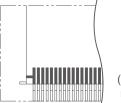
Fit the heatseal of a new LCD.



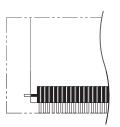


Heatweld with the tip of the soldering iron about 5 to 8 seconds (in case of 60W soldering iron).





(Vertical interval tolerance is more than 0.2 mm.)



NG

NG

(Horizontal interval tolerance is more than 0.2 mm.)

12 Measurements and Adjustments

This chapter explains the measuring equipment, the JIG connection, and the PC setting method necessary for the measurement in **Troubleshooting Guide** (P.29)

12.1. Equipment Required

- Digital multi-meter (DMM): it must be able to measure voltage and current.
- · Oscilloscope.
- Frequency counter: It must be precise enough to measure intervals of 1 Hz (precision; ±4 ppm) Hewlett Packard, 53131A is recommended.
- DECT tester: Rohde & Schwarz, CMD 60 is recommended.

 This equipment may be useful in order to precisely adjust like a mass production.

12.2. The Setting Method of JIG

<Preparation>

- Serial JIG cable: PQZZ1CD300E*
- PC which runs in DOS mode
- Batch file CD-ROM for setting: PNZZTG4771M

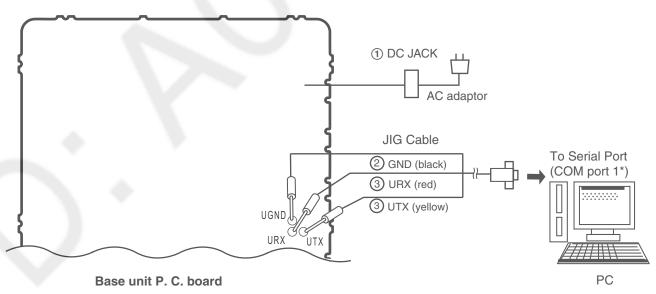
Note:

*: If you have the JIG Cable for TCD500 series (PQZZ1CD505E), change the following values of resistance. Then you can use it as a JIG Cable for both TCD300 and TCD500 series. (It is an upper compatible JIG Cable.)

Resistor	Old value (kΩ)	New value (kΩ)
R2	22	3.3
R3	22	3.3
R4	22	4.7
R7	4.7	10

12.2.1. Connections (Base Unit)

- 1 Connect the AC adaptor.
- ② Connect the JIG Cable GND (black).
- ③ Connect the JIG Cable RX (red) and TX (yellow).

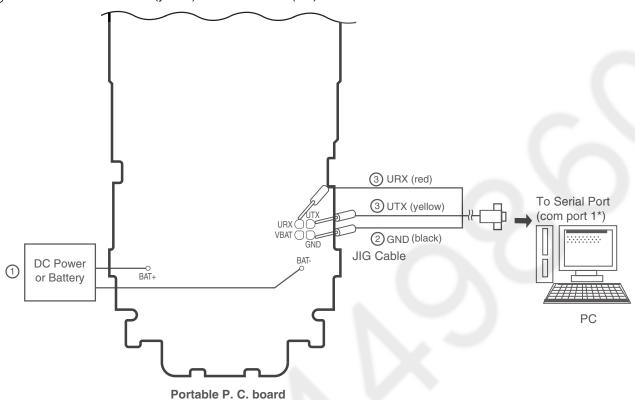


Note:

*: COM port names may vary depending on what your PC calls it.

12.2.2. Connections (Portable)

- ①Connect the DC Power or Battery to BATT+ and BATT-.
- ②Connect the JIG cable GND (black) to GND.
- ③Connect the JIG cable UTX (yellow) to UTX and URX (red) to URX.



Note:

*: COM port names may vary depending on what your PC calls it.

12.2.3. How to install Batch file into P.C.

- 1. Insert the Batch file CD-ROM into CD-ROM drive and copy PNZZTG**** folder to your PC (example: D drive).
- 2. Open an MS-DOS mode window.

<Example for Windows>

On your computer, click [Start], select Programs (All Programs for Windows XP/Windows Server 2003), then click

MS-DOS Prompt. (for Windows 95/Windows 98)

Accessories-MS-DOS Prompt. (for Windows Me)

Command Prompt. (for Windows NT 4.0)

)r

Accessories-Command Prompt.

(for Windows 2000/Windows XP/Windows Server 2003)

- **3.** At the DOS prompt, type "D:" (for example) to select the drive, then press the **Enter** key.
- **4.** Type "CD ¥PNZZTG****", then press the Enter key.
- Type "SET_COM=X", then press the Enter key
 (X: COM port number used for the serial connection on your PC).
- **6.** Type "**READID**", then press the **Enter** key.
 - •If any error messages appear, change the port number or check the cable connection.
 - •If any value appear, go to next step.
- **7.** Type "DOSKEY", then press the Enter key.

<Example>

- C: ¥Documents and Settings>D:
- D: ¥>CD ¥PNZZTG****
- D: ¥PNZZTG**** >SET_COM=X
- D: ¥PNZZTG****>READID
- 00 52 4F A8 A8
- D: ¥PNZZTG****>DOSKEY
- D: ¥PNZZTG****>_

<Example: error happens>

- C: ¥Documents and Settings>D:
- D: ¥>CD ¥PNZZTG****
- D: ¥PNZZTG**** >SET_COM=X
- D: ¥PNZZTG****>READID CreateFile error

ERROR 10: Can't open serial port

D: ¥PNZZTG ****>_

Note:

• "*****" varies depending on the country or models.

12.2.4. Commands (Base Unit)

See the table below for frequently used commands.

Command name		Function	Example	
rdeeprom		Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address "00 00" to "FF" is read out.	
readid		Read ID (RFPI)	Type "readid", and the registered ID is read out.	
writeid		Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 98" is written.	
hookoff		Off-hook mode on Base	Type "hookoff".	
hookon		On-hook mode on Base	Type "hookon".	
getchk		Read checksum	Type "getchk".	
How to use of "getchk"	1.rdeeprom	Read EEPROM	Type "RdEeprom 04 73 04", and the data from address "03 F2" to "03 F5" is read out *This command gets 4 byte "WW", "XX", "YY", "ZZ". *Please NEVER forget these 4 byte data!	
	2.sendchar epw	Write EEPROM	Type "sendchar epw 04 73 04 FF FF FF FF"	
	3.sendchar RST	Reset baseset	Type "sendchar RST"	
	4.getchk	Read checksum	Type "getchk".	
	5.sendchar epw	Write EEPROM	Type "sendchar epw 04 73 04 WW XX YY ZZ" *"WW", "XX", "YY", "ZZ" is 4 byte data that already read from same address.	
wreeprom		Write the data of EEPROM	Type "wreeprom 01 23 45". "01 23" is address and "45" is data to be written.	
bs_burst		Base unit outputs RF power in burst test mode on antenna 2	Type"bs_burst"	
tx_high		Keep TX power high	Type"tx_high"	
tx_low		Keep TX power low	Type"tx_low"	

12.2.5. Commands (Portable)

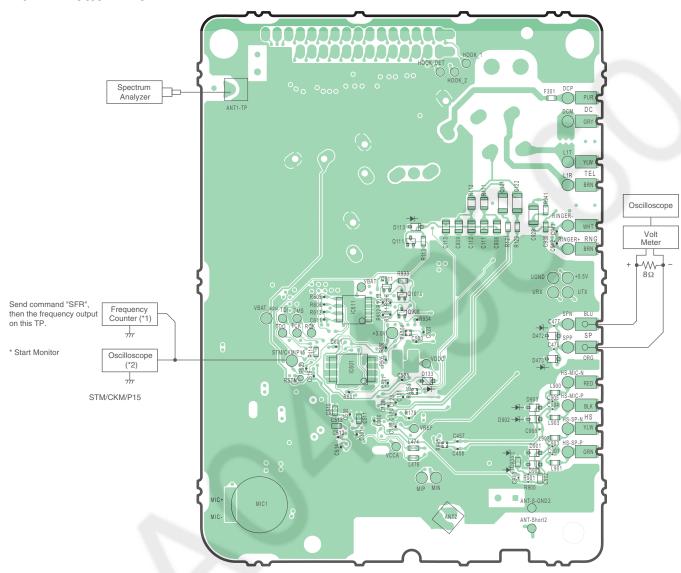
See the table below for frequently used commands.

Comi	mand name	Function	Example
rdeeprom		Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address
			"00 00" to "FF" is read out.
readid		Read ID (RFPI)	Type "readid", and the registered ID is read out.
writeid		Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 0E
			98" is written.
getchk		Read checksum	Type "getchk"
How to use of	1.rdeeprom	Read EEPROM	Type "RdEeprom 03 7D 04", and the data from address
"getchk"			"03 7D" to "03 80" is read out
			*NEVER forget the read 4 byte data!
	2.sendchar epw	Write EEPROM	Type "sendchar epw 03 7D 04 FF FF FF FF"
	3.sendchar RST	Reset baseset	Type "sendchar RST"
	4.getchk	Read checksum	Type "getchk".
	5.sendchar epw	Write EEPROM	Type "sendchar epw 03 7D 04 WW XX YY ZZ"
	•		*"WW", "XX", "YY", "ZZ" is 4 byte data that already read
			from same address.
weeprom		Write the data of EEPROM	Type "wreeprom 01 23 45". "01 23" is address and "45"
			is data to be written.
hs_burst		Portable outputs RF power in burst test	Type "hs_burst"
		mode	
tx_high		Keep TX power high	Type "tx_high"
tx_low		Keep TX power low	Type "tx_low"

12.3. Adjustment Standard (Base Unit)

When connecting the simulator equipment for checking, please refer to below.

12.3.1. Bottom View



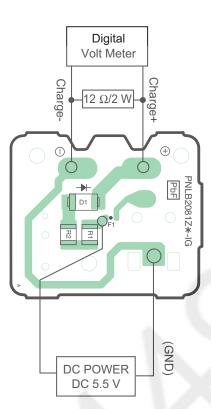
Note:

- (*1) is referred to No.2 of Check Check Table for RF part (P.39)
- (*2) is referred to **Power Supply Circuit/Reset Circuit** (P.12)

12.4. Adjustment Standard (Charger Unit)

When connecting the simulator equipment for checking, please refer to below.

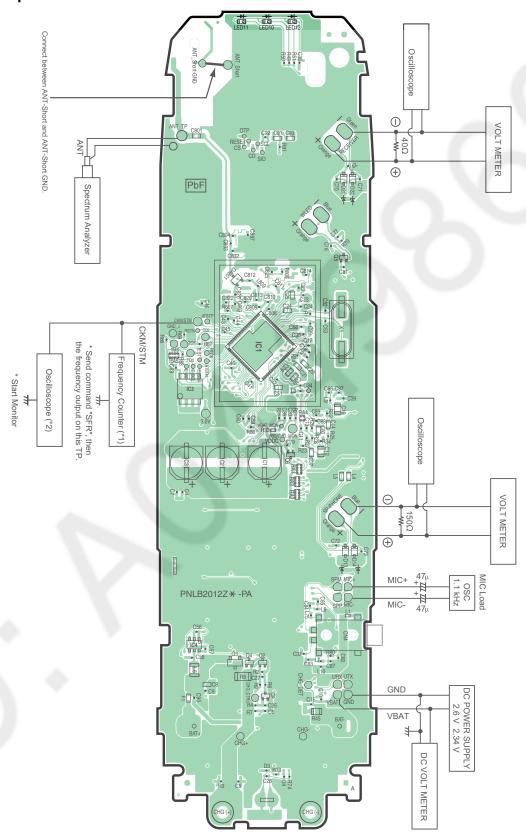
12.4.1. Bottom View



12.5. Adjustment Standard (Portable)

When connecting the simulator equipment for checking, please refer to below.

12.5.1. Component View



Note:

- (*1) is referred to No.2 of Check Check Table for RF part (P.39)
- (*2) is referred to **Power Supply Circuit/Reset Circuit** (P.18)

12.6. Things to Do after Replacing IC or X'tal

If repairing or replacing EEPROM and X'tal, it is necessary to download the required data such as Programming data or adjustment data, etc in memory.

The set doesn't operate if it is not executed.

12.6.1. How to download the data

12.6.1.1. Base Unit

First, operate the PC setting according to The Setting Method of JIG (P.49).

Then download the appropriate data according to the following procedures.

Items		How to download/Required adjustment
EEPROM (IC611)	Adjusted parameter data is stored in memory.	1) Change the address "0001" of EEPROM to "AA" to download
	(country version batch file, default batch file,	the data.
	etc.)	2) Default batch file: Execute the command "default.bat".
		3) Country version batch file: Execute the command
		"TG4771US_US_RevXXX_YYY.bat". (*1)
		4) Clock adjustment
X'tal (X1)	System clock	Clock adjustment data is in EEPROM, adjust the data again
		after replacing it.
		1) Apply 5.5V between DCP ad DCM with DC power.
		2) Input Command "sendchar sfr", then you can confirm the
		current value.
		3) Check X'tal Frequency.(13.824 MHz ± 83 Hz).
		4) If the frequency is not 13.824 MHz ± 83 Hz, adjust the
		frequency of CLK executing the command "sendchar sfr xx xx
		(where xx is the value)" so that the reading of the frequency
		counter is 13.824000 MHz ± 15 Hz.

Note:

(*1) XXX_YYY: revision number

"XXX" and "YYY" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG** (P.49).

12.6.1.2. Portable

First, operate the PC setting according to **The Setting Method of JIG** (P.49).

Then download the appropriate data according to the following procedures.

Items		How to download/Required adjustment
EEPROM (IC3)	Adjusted parameter data is stored in memory.	Default batch file: Execute the command "default.bat".
	(country version batch file, default batch file,	2) Default batch file (remaining): Execute the command
	etc.)	"TGA470US_DEF_RevXXX_YYY.bat". (*2)
		3) Country version batch file: Execute the command
		"TGA470US_US_RevXXX_YYY.bat". (*2)
		4) Clock adjustment
		5) 2.35 V setting and battery low detection
X'tal (X1)	System clock	1) Apply 2.6V between BATT+ and BATT- with DC power.
		2) Input Command "sendchar sfr", then you can confirm the
		current value.
		3) Check X'tal Frequency.(13.824 MHz ± 83 Hz).
		4) If the frequency is not 13.824 MHz ± 83 Hz, adjust the
		frequency of CLK executing the command "sendchar sfr xx xx
		(where xx is the value)" so that the reading of the frequency
		counter is 13.824000 MHz ± 5 Hz.

Note:

(*2) XXX_YYY: revision number

"XXX" and "YYY" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG** (P.49).

12.7. Frequency Table

	Ch. (hex)	TX/RX Frequency (MHz)
Channel 0	00	1928.448
Channel 1	01	1926.720
Channel 2	02	1924.992
Channel 3	03	1923.264
Channel 4	04	1921.536

13 Miscellaneous

13.1. How to Replace the LLP (Leadless Leadframe Package) IC

Note:

This description is only applied on the model with Shield case.

13.1.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of 700 °F ± 20 °F (370 °C ± 10 °C)

Note:

We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

· Hot Air Desoldering Tool

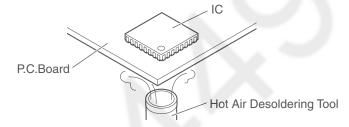
Temperature: 608 °F ± 68 °F (320 °C ± 20 °C)

13.1.2. Caution

- To replace the IC efficiently, choose the right sized nozzle of the hot air desoldering tool that matches the IC package.
- Be careful about the temperature of the hot air desoldering tool not to damage the PCB and/or IC.

13.1.3. How to Remove the IC

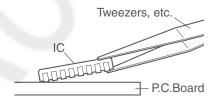
1. Heat the IC with a hot air desoldering tool through the P.C.Board.



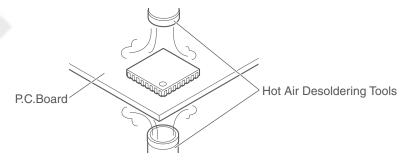
2. Pick up the IC with tweezers, etc. when the solder is melted completely.

Note:

• Be careful not to touch the peripheral parts with tweezers, etc. They are unstable.



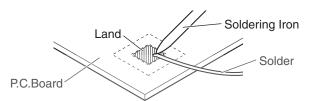
When it is hard to melt the solder completely, heat it with a hot air desoldering tool through the IC besides through the P.C.Board.



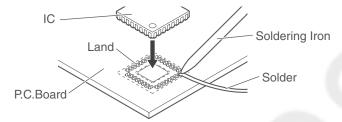
3. After removing the IC, clean the P.C.Board of residual solder.

13.1.4. How to Install the IC

1. Place the solder a little on the land where the radiation GND pad on IC bottom is to be attached.

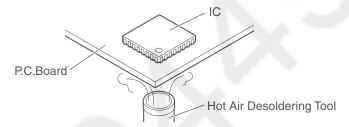


- 2. Place the solder a little on the land where IC pins are to be attached, then place the IC. **Note:**
 - When placing the IC, the positioning should be done very carefully.



- 3. Heat the IC with a hot air desoldering tool through the P.C.Board until the solder on IC bottom is melted.

 Note:
 - Be sure to place it precisely, controlling the air volume of the hot air desoldering tool.



4. After soldering, confirm there are no short and open circuits with visual inspection.

13.2. How to Replace the Flat Package IC

Even if you do not have the special tools (for example, a spot heater) to remove the Flat IC, with some solder (large amount), a soldering iron and a cutter knife, you can easily remove the ICs that have more than 100 pins.

13.2.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of 700 °F \pm 20 °F (370 °C \pm 10 °C)

Note: We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

Flux

Recommended Flux: Specific Gravity \rightarrow 0.82.

Type → RMA (lower residue, non-cleaning type)

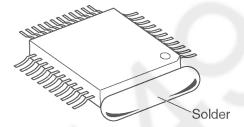
Note: See About Lead Free Solder (PbF: Pb free) (P.4)

13.2.2. How to Remove the IC

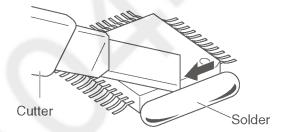
1. Put plenty of solder on the IC pins so that the pins can be completely covered.

Note:

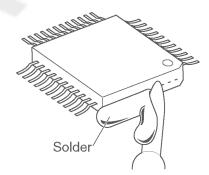
If the IC pins are not soldered enough, you may give pressure to the P.C. board when cutting the pins with a cutter.



2. Make a few cuts into the joint (between the IC and its pins) first and then cut off the pins thoroughly.



3. While the solder melts, remove it together with the IC pins.



When you attach a new IC to the board, remove all solder left on the board with some tools like a soldering wire. If some solder is left at the joint on the board, the new IC will not be attached properly.

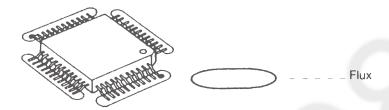
13.2.3. How to Install the IC

1. Temporarily fix the FLAT PACKAGE IC, soldering the two marked pins.

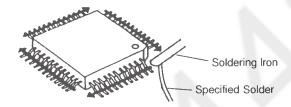


*Check the accuracy of the IC setting with the corresponding soldering foil.

2. Apply flux to all pins of the FLAT PACKAGE IC.



3. Solder the pins, sliding the soldering iron in the direction of the arrow.



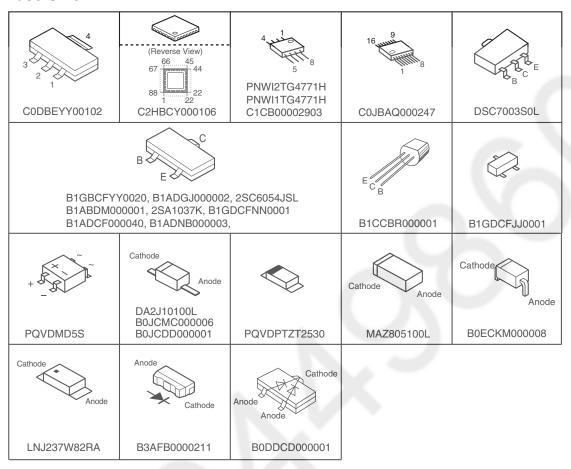
13.2.4. How to Remove a Solder Bridge

- 1. Lightly resolder the bridged portion.
- 2. Remove the remaining solder along the pins using a soldering iron as shown in the figure below.

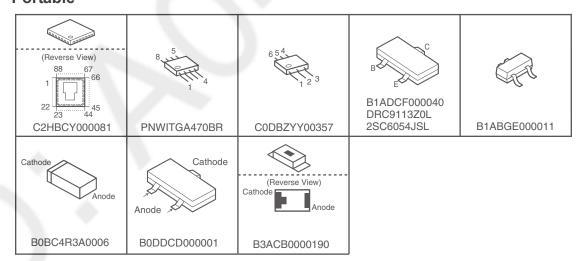


13.3. Terminal Guide of the ICs, Transistors and Diodes

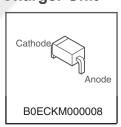
13.3.1. Base Unit



13.3.2. Portable



13.3.3. Charger Unit



14 Schematic Diagram

14.1. For Schematic Diagram

14.1.1. Base Unit (Base Unit (Main))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

Components identified by \triangle mark have special characteristics important for safety. When replacing any of these components, use only the manufacture's specified parts.

2. The schematic diagrams may be modified at any time with the development of new technology.

14.1.2. Portable (Portable (Main))

Notes:

- 1. DC voltage measurements are taken with an oscilloscope or a tester with a ground.
- 2. The schematic diagrams may be modified at any time with the development of new technology.

14.1.3. Charger Unit (Charger Unit)

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

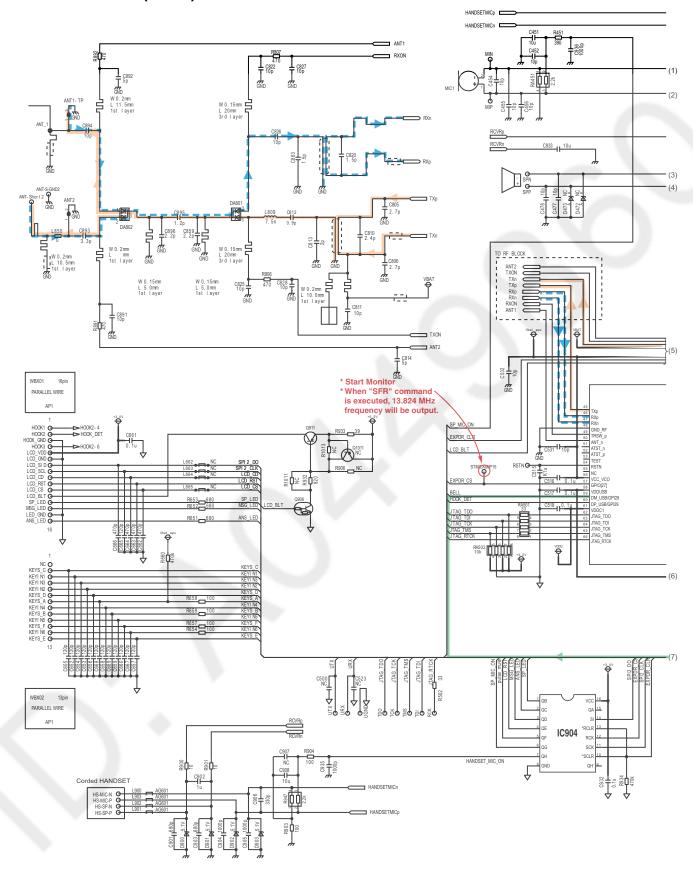
Important Safety Notice:

Components identified by \triangle mark have special characteristics important for safety. When replacing any of these components, use only the manufacture's specified parts.

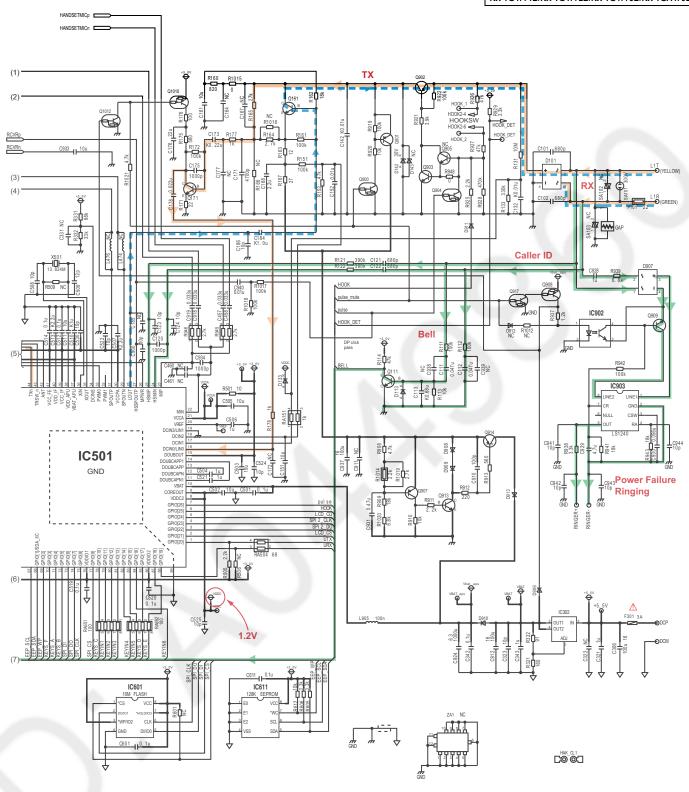
2. The schematic diagrams may be modified at any time with the development of new technology.

Memo

14.2. Base Unit (Main)

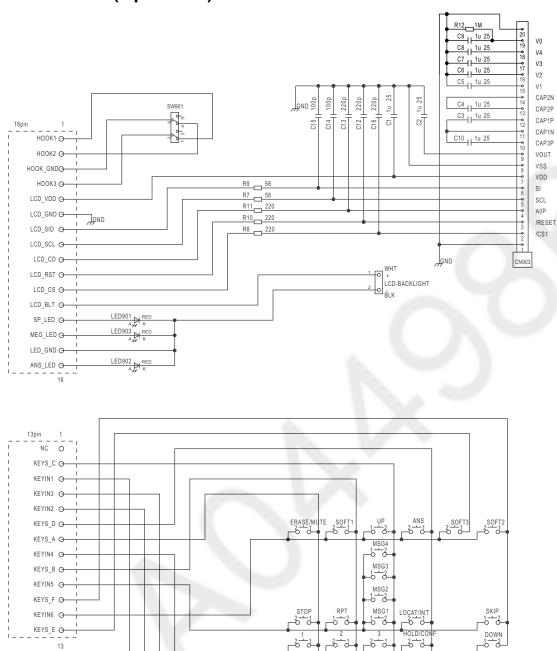


NC: No Components



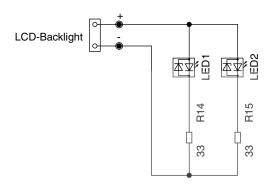
NC: No Components KX-TG4771 SCHEMATIC DIAGRAM (Base Unit (Main))

14.3. Base Unit (Operation)



NC: No Components KX-TG4771 SCHEMATIC DIAGRAM (Base Unit (Operation))

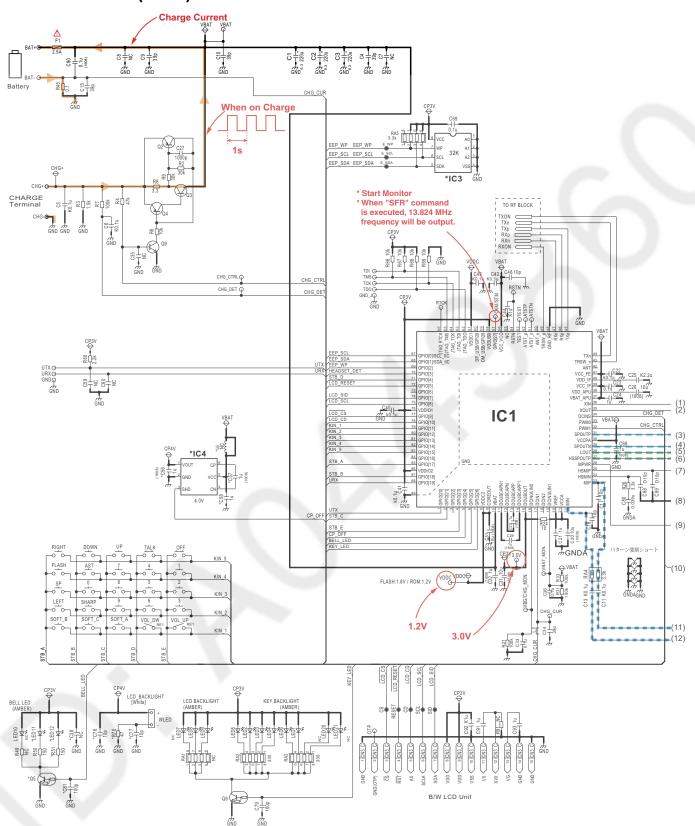
14.4. Base Unit (LED)



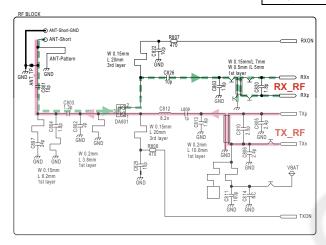
NC: No Components

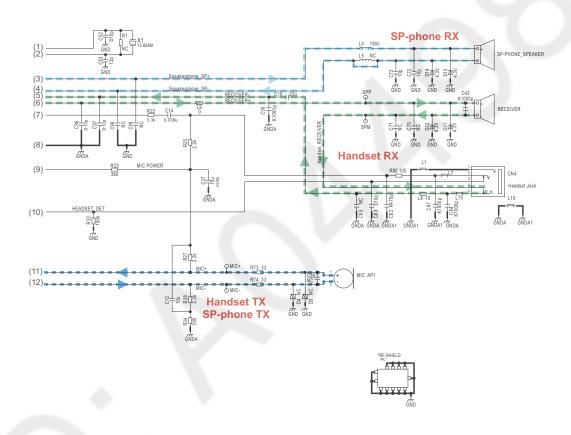
KX-TG4771 SCHEMATIC DIAGRAM (Base Unit (LED))

14.5. Portable (Main)



NC: No Components





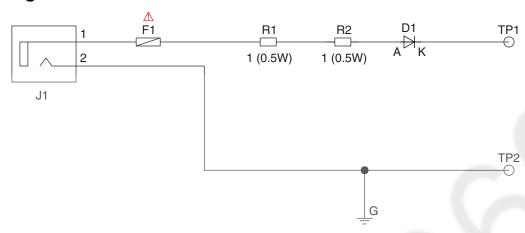
NC: No Components KX-TGA470 SCHEMATIC DIAGRAM (Handset (Main))

14.6. Portable (LED)



KX-TGA470 SCHEMATIC DIAGRAM (Handset (LED))

14.7. Charger Unit



SCHEMATIC DIAGRAM (Charger Unit)

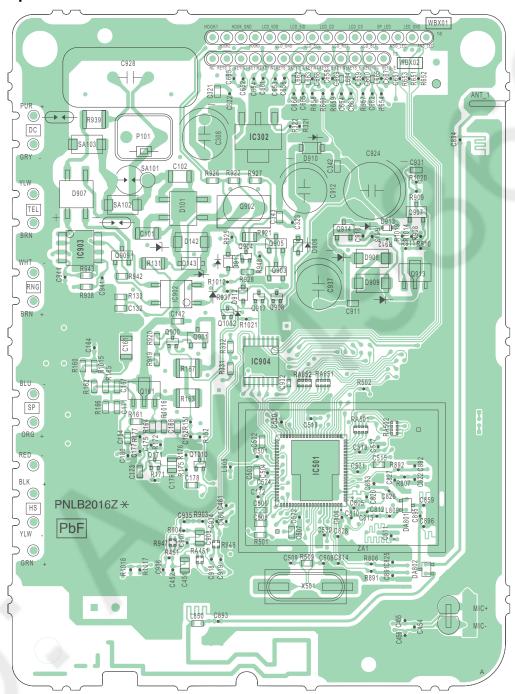
KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

Memo

15 Printed Circuit Board

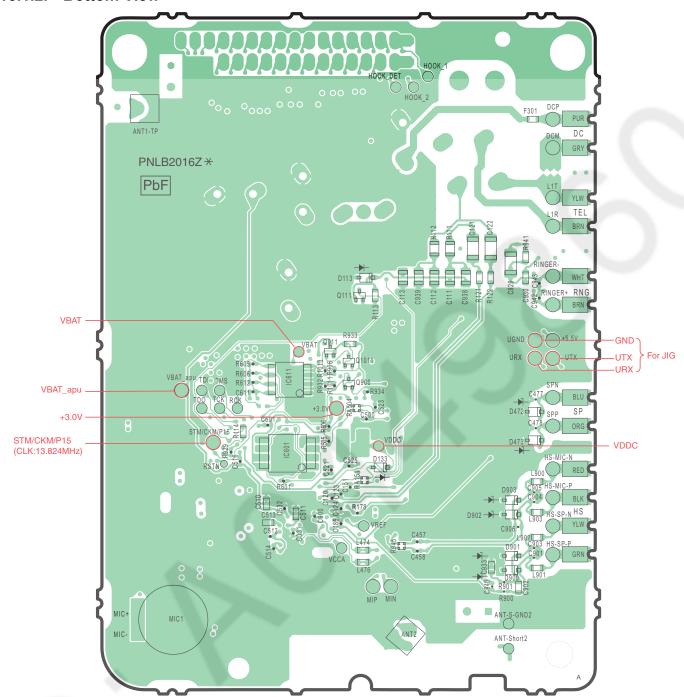
15.1. Base Unit (Main)

15.1.1. Component View



KX-TG4771 CIRCUIT BOARD (Base Unit (Main) (Component View))

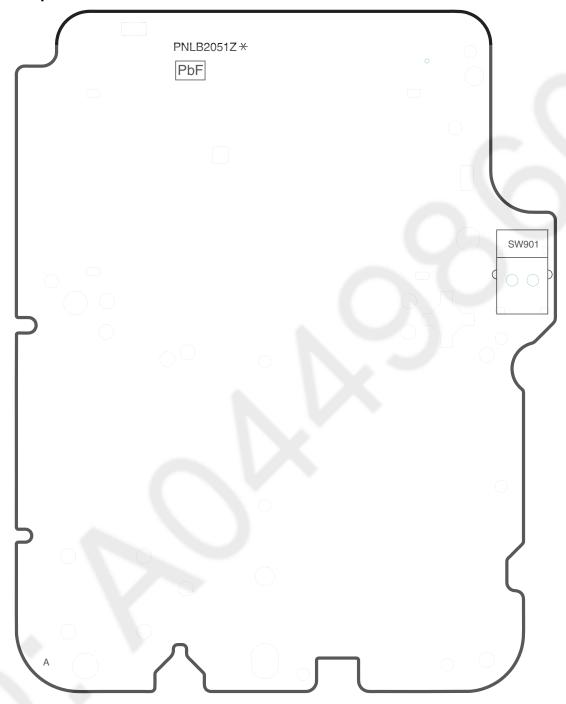
15.1.2. Bottom View



KX-TG4771 CIRCUIT BOARD (Base Unit (Main) (Bottom View))

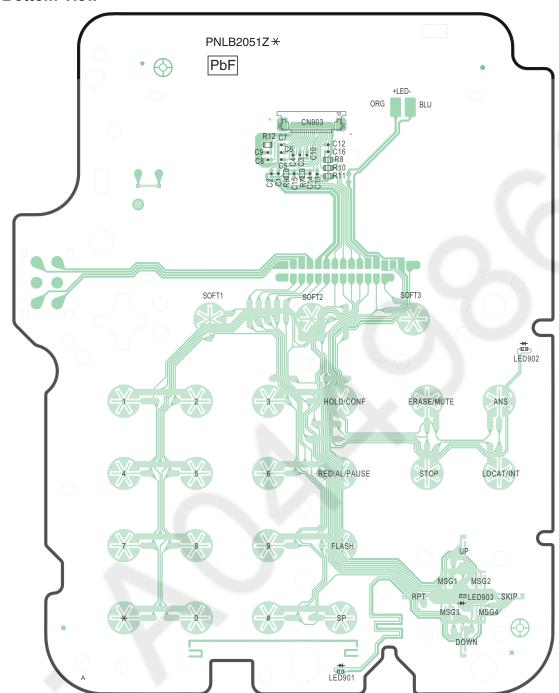
15.2. Base Unit (Operation)

15.2.1. Component View



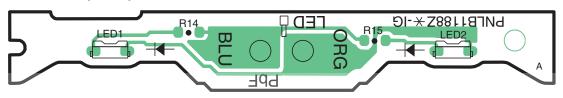
KX-TG4771 CIRCUIT BOARD (Base Unit (Operation) (Component View))

15.2.2. Bottom View



KX-TG4771 CIRCUIT BOARD (Base Unit (Operation) (Bottom View))

15.3. Base Unit (LED)



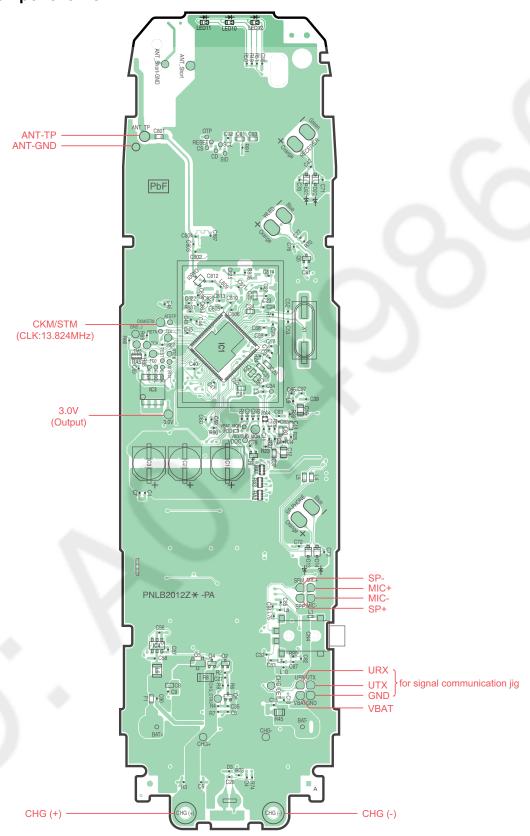
KX-TG4771 CIRCUIT BOARD (Base Unit (LED) (Component View))

KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

Memo

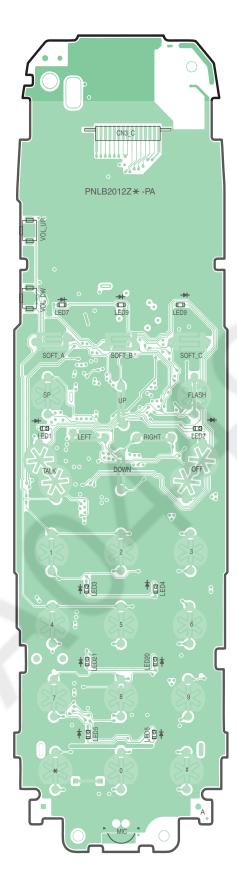
15.4. Portable (Main)

15.4.1. Component View



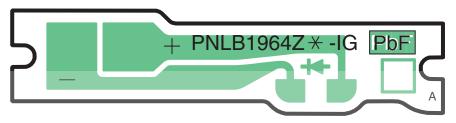
KX-TGA470 CIRCUIT BOARD (Portable (Main) (Component View))

15.4.2. Bottom View



KX-TGA470 CIRCUIT BOARD (Portable (Main) (Bottom View))

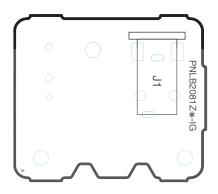
15.5. Portable (LED)



KX-TGA470 CIRCUIT BOARD (Portable (LED) (Component View))

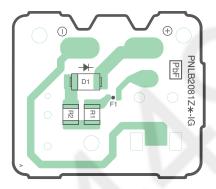
15.6. Charger Unit

15.6.1. Component View



CIRCUIT BOARD (Charger Unit (Component View))

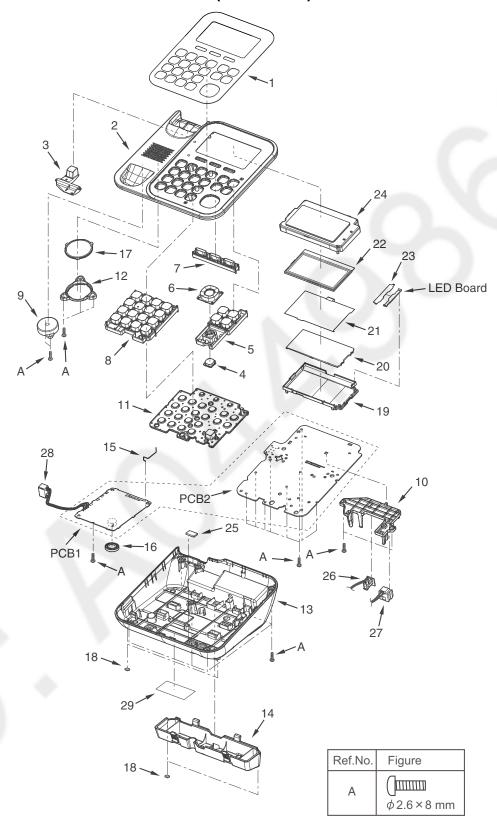
15.6.2. Bottom View



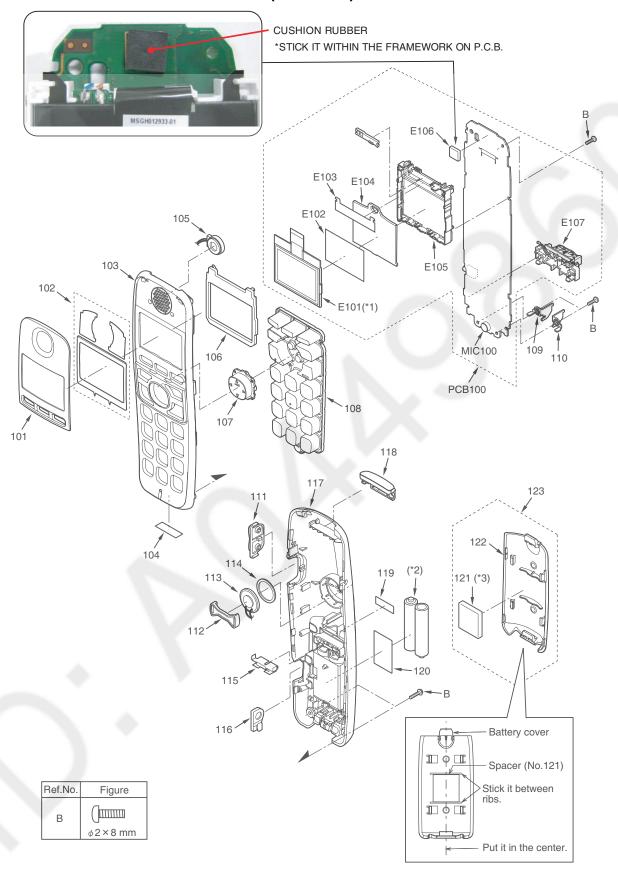
CIRCUIT BOARD (Charger Unit (Bottom View))

16 Exploded View and Replacement Parts List

16.1. Cabinet and Electrical Parts (Base Unit)



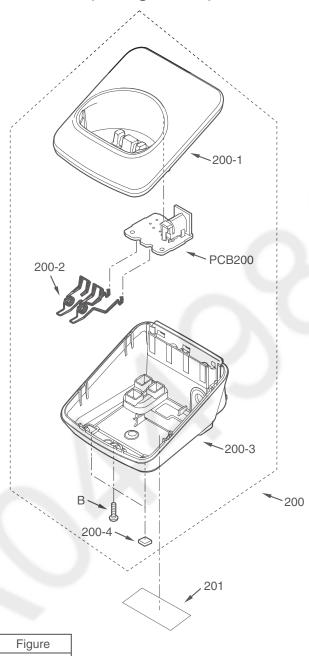
16.2. Cabinet and Electrical Parts (Portable)



Note:

- (*1) This cable is fixed by welding. Refer to **How to Replace the Portable LCD** (P.48).
- (*2) The rechargeable Ni-MH battery HHR-4DPA is available through sales route of Panasonic.
- (*3) Attach the SPACER (No. 121) to the exact location described above.

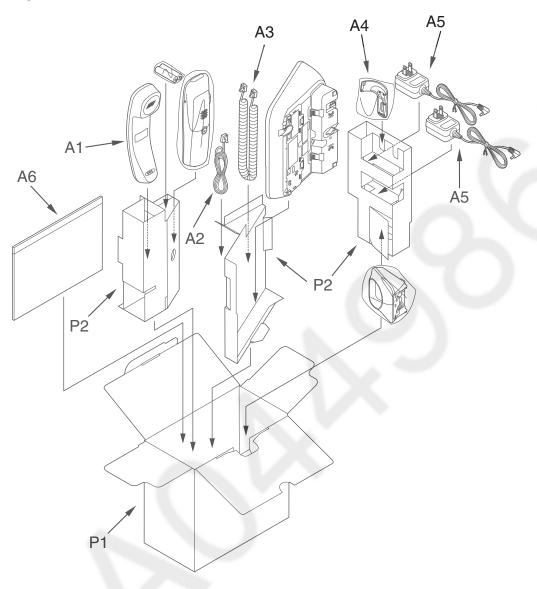
16.3. Cabinet and Electrical Parts (Charger Unit)



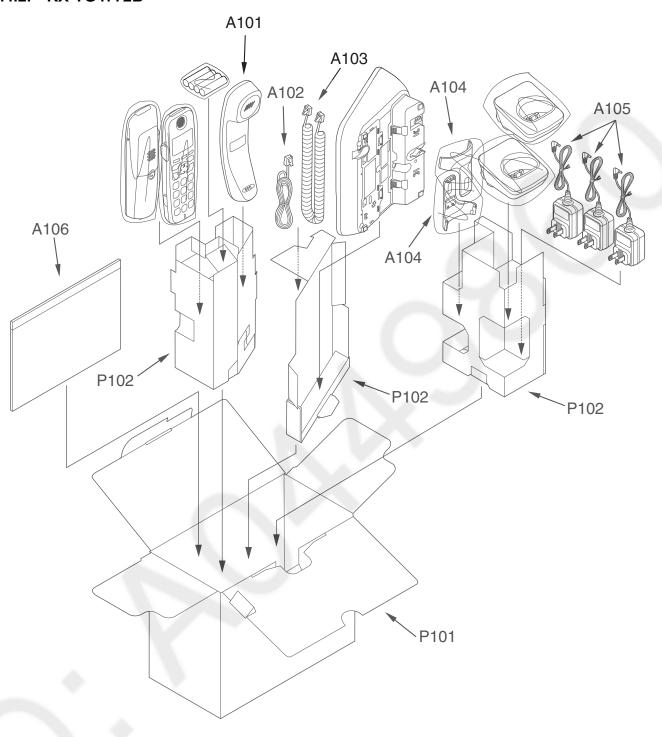
Ref.No.	Figure
В	 φ2×8 mm

16.4. Accessories and Packing Materials

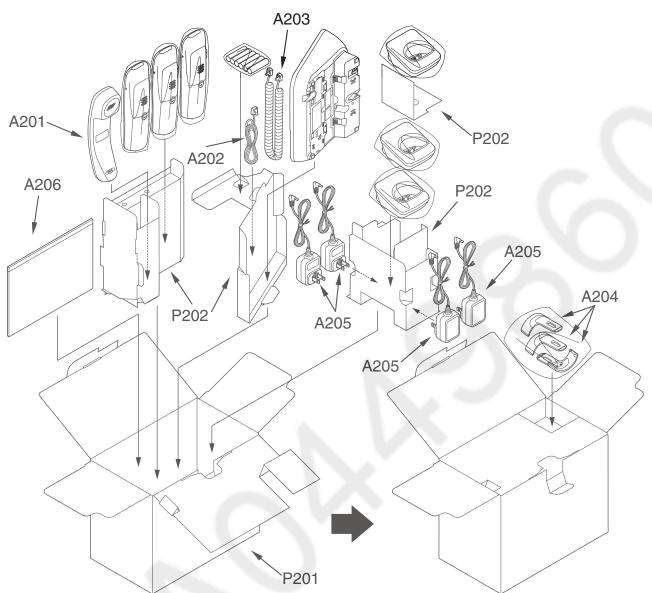
16.4.1. KX-TG4771B



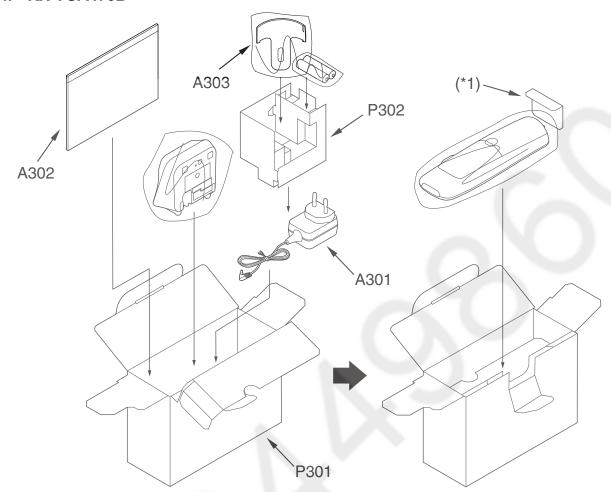
16.4.2. KX-TG4772B



16.4.3. KX-TG4773B



16.4.4. KX-TGA470B



Note: (*1) This pad is a piece of Ref. No. P301 (GIFT BOX).

16.5. Replacement Parts List

1. RTL (Retention Time Limited)

Note:

The "RTL" marking indicates that its Retention Time is Limited.

When production is discontinued, this item will continue to be available only for a specific period of time.

This period of time depends on the type of item, and the local laws governing parts and product retention. At the end of this period, the item will no longer be available.

2. Important safety notice

Components identified by the \triangle mark indicates special characteristics important for safety. When replacing any of these components, only use specified manufacture's parts.

- The S mark means the part is one of some identical parts.For that reason, it may be different from the installed part.
- ISO code (Example: ABS-94HB) of the remarks column shows quality of the material and a flame resisting grade about plastics.
- 5. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) k=1000 Ω , M=1000k Ω All capacitors are in MICRO FARADS (μ F) p= $\mu\mu$ F *Type & Wattage of Resistor

Type

ERC:Solid ERDS:Carbon ERJ:Chip	ERX:Metal Filn ERG:Metal Oxi ER0:Metal Film		tal Oxide	E	PQ4R:Chip ERS:Fusible Resistor ERF:Cement Resistor		
Wattage							
10,16:1/8W	14,2	5:1/4W	12:1/2W		1:1W	2:2W	3:3W

*Type & Voltage Of Capacitor
Type

ECFD:Semi-Conductor	ECCD,ECKD,ECBT,F1K,ECUV:Ceramic
	ECQE,ECQV,ECQG:Polyester
	ECEA,ECST,EEE:Electlytic
ECQMS:Mica	ECQP:Polypropylene

Voltage

ECQ Type	ECQG ECQV Type	ECSZ Type		Oth	ers	
1H:50V 2A:100V 2E:250V 2H:500V	1:100V 2:200V	0F:3.15V 1A:10V 1V:35V 0J:6.3V	0J 1A 1C 1E,2	:6.3V :10V :16V 5:25V	1V 50,1 1J 2A	:35V H:50V :16V :100V

16.5.1. Base Unit

16.5.1.1. Cabinet and Electrical Parts

Safety	Ref.	Part No.	Part Name & Descrip-	Remarks
	No.		tion	
	1	PNGP1236Z1	PANEL, UPPER	PC-HB
	2	PNKM1268Z1	CABINET BODY	PS-HB
	3	PNBH1017Z1	BUTTON, HOOK	ABS-HB
	4	PNBC1345Z1	BUTTON, MESSAGE	PMMA-HB
	5	PNBX1306Z1	BUTTON, TAM	ABS-HB
	6	PNBC1404W3	BUTTON, NAVIGATOR KEY	ABS-HB
	7	PNBX1307Z1	BUTTON, FUNCTION	ABS-HB
	8	PNBX1305Z1	BUTTON, DIAL KEY	ABS-HB
	9	L0DDYD000010	BUZZER	
	10	PNHR1605Z	GUIDE, JACK HOLDER	PS-HB
	11	PNJK1154Z	KEYBOARD SWITCH, DIAL	
	12	PQHR11082Z	GUIDE, SPEAKER	POM-HB
	13	PNKF1235Z1	CABINET COVER	PS-HB

Safety		Part No.	Part Name & Descrip-	Remarks
	No.		tion	
	14	PNKL1037Z1	STAND, WALL MOUNT	ABS-HB
	15	PNLA1088Z	ANTENNA	
	16	PQMG10025W	RUBBER PARTS, MIC	
	17	L0AA04A00028	SPEAKER	
	18	PNHA1013Z	RUBBER PARTS, FOOT CUSHION	
	19	PNHR1606Z	GUIDE, LCD	ABS-HB
	20	PNHR1607Z	PLASTIC PARTS, LCD PLATE	PMMA-HB
	21	PNHX1514Z	PLASTIC PARTS, DEFFUSION SHEET	
	22	L5DYBYY00042	LIQUID CRYSTAL DISPLAY	
	23	PNHX1515Z	PLASTIC PARTS, REFLECTOR SHEET	
	24	PNGP1237Z1	PANEL, LCD	PC-HB
	25	PNYE1065Y	SPACER, CUSHION LCD	
	26	K2ECYZ000001	JACK, DC	
	27	PQJJ1T039J	JACK, MODULAR	
	28	PQJJ1T030N	JACK, HANDSET	
	29	PNGT6470Z	NAME PLATE	

16.5.1.2. Main P.C. Board Parts

Note:

(*1) When replacing IC611 or X501, make the adjustment using PNZZTG4771M. Refer to **How to download the data** (P.56) of Things to Do after Replacing IC or X'tal.

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB1	PNWP1TG4771H	MAIN P.C.BOARD ASS'Y	
			(RTL)	
			(ICs)	
	IC302	C0DBEYY00102	IC	
	IC501	C2HBCY000106	IC	
	IC601	PNWI2TG4771H	IC	
	IC611	PNWI1TG4771H	IC (*1)	
	IC903	C1CB00002903	IC	
	IC904	C0JBAQ000247	IC	
			(TRANSISTORS)	
	Q111	2SC6054JSL	TRANSISTOR(SI)	S
	Q161	DSC7003S0L	TRANSISTOR(SI)	
	Q171	2SC6054JSL	TRANSISTOR(SI)	S
	Q900	B1GBCFYY0020	TRANSISTOR(SI)	
	Q901	B1ADGJ000002	TRANSISTOR(SI)	
	Q902	B1CCBR000001	TRANSISTOR(SI)	
	Q903	B1ABDM000001	TRANSISTOR(SI)	
	Q904	B1GBCFYY0020	TRANSISTOR(SI)	
	Q906	B1GBCFYY0020	TRANSISTOR(SI)	
	Q907	2SA1037K	TRANSISTOR(SI)	S
	Q908	B1GDCFNN0001	TRANSISTOR(SI)	
	Q909	B1ABDM000001	TRANSISTOR(SI)	
	Q911	B1ADCF000040	TRANSISTOR(SI)	
	Q913	DSC7003S0L	TRANSISTOR(SI)	
	Q914	B1ADNB000003	TRANSISTOR(SI)	
	Q917	B1GBCFYY0020	TRANSISTOR(SI)	
	Q1010	B1GDCFJJ0001	TRANSISTOR(SI)	
	Q1012	B1GBCFYY0020	TRANSISTOR(SI)	
			(DIODES)	
	D101	PQVDMD5S	DIODE(SI)	
	D113	DA2J10100L	DIODE(SI)	
	D133	DA2J10100L	DIODE(SI)	
	D142	PQVDPTZT2530	DIODE(SI)	S
	D900	MAZ805100L	DIODE(SI)	S
	D901	MAZ805100L	DIODE(SI)	S
	D902	MAZ805100L	DIODE(SI)	S
	D903	MAZ805100L	DIODE(SI)	S
	D906	DA2J10100L	DIODE(SI)	
	D907	PQVDMD5S	DIODE(SI)	İ
	D908	B0ECKM000008	DIODE(SI)	1
	D909	B0ECKM000008	DIODE(SI)	
	D910	B0JCMC000006	DIODE(SI)	
	D911	DA2J10100L	DIODE(SI)	
	D913	B0JCDD000001	DIODE(SI)	1

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	DA801	B0DDCD000001	DIODE(SI)	
	DA802	B0DDCD00001	DIODE(SI)	
			(COILS)	
	L809	G1C7N5JA0044		
	L900	PQLQR2KA20T	COIL	S
	L901	PQLQR2KA20T	COIL	S
	L902	PQLQR2KA20T	COIL	S
	L903	PQLQR2KA20T	COIL	S
	L905	G1CR10J00010		
	D31F1	D1 1141 0000001	(RESISTOR ARRAYS)	
	RA151 RA451		RESISTOR ARRAY	
	RA501	EXB28V330	RESISTOR ARRAY RESISTOR ARRAY	
	RA501	EXB28V103	RESISTOR ARRAY	
	RA502		RESISTOR ARRAY	
	RA651	EXB28V101JX	RESISTOR ARRAY	
	RA652	EXB28V101JX	RESISTOR ARRAY	
	MOSZ	EXDZOVIOIOX	(VARISTOR)	
	SA101	PQVDDSS301L	VARISTOR	!s
	SAIUI	FQVDD33301L	(RESISTORS)	:5
	R111	PQ4R10XJ104	100k	S
	R112	PQ4R10XJ104	100k	S
	R113	D0GB103JA057		
	R114	D0GB103JA057		
	R121	ERJ3GEYJ394	390k	s
	R122	ERJ3GEYJ394	390k	S
	R131	PQ4R18XJ106	10M	S
	R133	ERJ3GEYJ334	330k	S
	R151	D0GA104JA021		_
	R152	D0GA473JA021		
	R160	ERJ3GSYJ821	820	s
	R161	D0GB104JA057		_
	R162	ERJ3GSYJ183	18k	S
	R163	ERJ14YJ120U	12	
	R164	D0GB272JA057	2.7k	
	R165	ERJ3GEYJ273	27k	S
	R167	D0GG270JA007		
	R171	D0GA220JA021		
	R172	D0GA104JA021		
	R175	D0GA561JA021		
	R176	D0GA101JA021	100	
	R177	D0GA102JA021	1k	
	R178	D0GA102JA021	1k	
	R321	ERJ2RKF161X	160	
	R322	ERJ2RKF910X	91	
	R331	ERJ3EKF6802	68k	
	R332	ERJ3EKF3302	33k	
	R451	ERJ2GEYJ391	390	S
	R501	D0GB100JA057		
	R502	D0GA330JA015		
	R505	D0GA222JA021		
	R605	D0GA332JA015	3.3k	
	R606	D0GA332JA015		
	R612	D0GA103JA021		
	R651	D0GA681JA021	680	
	R652	D0GA681JA021	680	
	R653	D0GA681JA021	680	İ
	R654	D0GA101JA021	100	
	R657	D0GA101JA021	100	
	R658	D0GA101JA021	100	
	R659	D0GA101JA021	100	
	R660	ERJ2GEJ474X	470k	s
	R806	ERJ2GEJ471	470	s
	R807	ERJ2GEJ471	470	s
	R891	ERJ2GEJ471	470	s
	R892	ERJ2GEJ471	470	s
	R900	ERJ2GEJ100	10	S
	R901	ERJ2GEJ100	10	S
	R903	D0GA101JA021	100	
	R904	D0GA101JA021	100	
	R908	ERJ2RKF472X	4.7k	
	R909	ERJ2RKF183X	18k	
	R910	D0GA103JA021	10k	

Safety	Ref.	Part No.	Part Name & Description	Remarks
Salety	No.	FAIC NO.	rait Name & Description	Kelliaiks
	R911	D0GA222JA021	2.2k	
	R912	D0GA221JA021	220	
	R913	D0GA561JA021	560	
	R919	D0GB104JA057	100k	
	R920	D0GB103JA057	10k	
	R921	PQ4R10XJ392	3.9k	S
	R922	D0GB104JA057	100k	
	R925	D0GA222JA021	2.2k	
	R926	D0GB473JA057	47k	
	R927	D0GB473JA057	47k	
	R928	ERJ3GEYJ474	470k	S
	R929	D0GA332JA015	3.3k	
	R932	D0GA821JA021	820	
	R933	ERJ3GEYJ390	39	
	R934	ERJ2GEJ474X	470k	S
	R937	D0GA122JA015	1.2k	
	R938	ERJ3GEYJ332	3.3k	S
	R939	ERJ14YJ682	6.8k	
	R941	ERJ3GSYJ183	18k	S
	R942	D0GB104JA057	100k	
	R943	ERJ3GSYJ183	18k	S
	R945	D1H427220001	2.7k	
	R946	D1H427220001	2.7k	
	R947	D1H422220001	2.2k	
	R948	ERJ2GE0R00	0	S
	R1014	D4CC1222A033	2.2k	
	R1015	ERJ3GEY0R00	0	S
	R1017	D0GA104JA021		
	R1018	D0GA104JA021	100k	
	R1019	D0GA272JA021	2.7k	
	R1020	ERJ2RKF682X	6.8k	
	R1021	D0GA472JA021		
	L850	ERJ3GEY0R00	0	S
			(CAPACITORS)	
	C101	F1K2H681A008	-	
	C102	F1K2H681A008	-	
	C111	F1J2A473A024		
	C112	F1J2A473A024		
	C113	PQCUV1A684KB		_
	C120	ECUE1H102KBQ		S
	C121	F1K2H681A008	•	
	C122	F1K2H681A008 ECUE1H100DCQ	_	
	C124	ECUE1H100DCQ ECUE1H100DCQ	_	S
	C124			3
	C132	ECUV1H103KBV ECUV1H103KBV		
	C142	ECUE1H103RBV		S
	C151	ECUE1C103KBQ	_	S
	C152	F1K1E1060001		5
	C168	ECUV1A225KBV		S
	C171	ECUV1H472KBV		-
	C171	ECUV1A224KBV		
	C175	ECUE1H102KBQ		S
	C176	F1J0J2260004		-
	C178	ECUV1C223KBV		
	C176	ECUV1A105KBV		
	C186	ECUE1H100DCQ		s
	C306	F2A1C1010119		
	C321	ECUV1A105KBV		
	C323	ECUE1H100DCQ		s
	C342	ECUV1C104KBV		-
	C343	ECUV1A105KBV		
	C451	PQCUV0J106KB		S
	C452	ECUE1H100DCQ		S
	C454	ECUE1H100DCQ		S
	C455	ECUE1H100DCQ		S
				S
	C456	ECUETHIOODCO		1
	C456 C457	ECUE1H100DCQ ECUE1C333KBQ	0.033	S
		ECUE1C333KBQ ECUE1C333KBQ		s s
	C457	ECUE1C333KBQ	0.033	
	C457 C458	ECUE1C333KBQ ECUE1C333KBQ	0.033 10p	S
	C457 C458 C477	ECUE1C333KBQ ECUE1C333KBQ ECUE1H100DCQ	0.033 10p 10p	S S

KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

Safety	Ref. No.	Part No.	Part Name & Description	
	C503	ECJ1VB0G106M	10	s
	C504	ECUE0J105KBQ		
	C505	ECJ1VB0G106M		S
	C506	ECUV1A105KBV		
	C507	ECUV1A225KBV		S
	C508	ECUE1H100DCQ ECUE1H120JCQ		S
	C510	ECUV1A105KBV		S
	C510	ECJ1VB0G106M		C
	C511	ECUE1A104KBQ		S
		ECUV1A225KBV		
	C513			S
	1 1	ECUE1A104KBQ		
	C515	ECUV1A105KBV		
	C516	ECUE1A104KBQ		
	C517	ECUE1A104KBQ		
	C518	ECUE1A104KBQ		
	C519	ECUE1A104KBQ		
	C520	ECUE1A104KBQ		
	C521	ECUE0J105KBQ		
	C522	ECUE1H100DCQ		S
	C524	ECUE1H100DCQ		S
	C525	ECUE1H100DCQ	*	S
	C530	ECUE1H100DCQ	-	S
	C531	ECUE1H100DCQ		S
	C532	ECUE1H100DCQ		S
	C601	ECUE1A104KBQ		
	C611	ECUE1A104KBQ		
	C652	ECUE1H121JCQ	_	S
	C653	ECUE1H121JCQ	120p	S
	C654	ECUE1H121JCQ	120p	S
	C655	ECUE1H121JCQ	120p	S
	C656	ECUE1H121JCQ	120p	S
	C657	ECUE1H121JCQ	120p	S
	C658	ECUE1H121JCQ	120p	S
	C659	ECUE1H121JCQ	120p	S
	C660	ECUE1H121JCQ	120p	S
	C661	ECUE1A104KBQ	0.1	
	C662	ECUE1H471KBQ	470p	S
	C663	ECUE1H471KBQ	470p	S
	C664	ECUE1H471KBQ	470p	S
	C665	ECUE1H121JCQ	120p	S
	C666	ECUE1H471KBQ	470p	S
	C667	ECUE1H121JCQ	120p	S
	C668	ECUE1H121JCQ	120p	S
	C669	ECUE1H121JCQ	120p	S
	C805	F1G1H2R7A480		
	C806	F1G1H2R7A480		
	C810	F1G1H2R4A480		
	C811	ECUE1H100DCQ		S
	C812	F1G1HR90A480		
	C813	F1G1H2R0A480		
	C814	F1G1H5R0A480		
	C820	F1G1H1R5A480		
	C822	ECUE1H100DCQ	_	S
	C825	ECUE1H100DCQ		S
	C826	ECUE1H100DCQ		S
	C827	ECUE1H100DCQ	_	S
	C828	ECUE1H100DCQ	_	S
	C859	F1G1H2R2A480		
	C863	F1G1H2R2A480		
	C891	ECUE1H100DCQ		S
	C891	F1G1H5R0A480	_	5
	C892		_	
		F1G1H3R3A480		e e
	C894	ECUE1H100DCQ	_	S
	C895	F1G1H1R2A480		
	C896	F1G1H2R2A480	_	_
	C900	ECUE1H100DCQ		S
	C901	ECUE1H681KBQ		S
	C902	ECUV1A105KBV		
	C903	ECUE1H681KBQ		s
	C904	ECUE1H102KBQ		S
	C905	ECUE1H102KBQ		s
	C906	ECUE1H331KBQ		S

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C908	PQCUV0J106KB	10	S
	C910	ECUE1H101JCQ	100p	
	C912	F2A1C1010119	100	
	C918	ECUE1C333KBQ	0.033	S
	C919	ECUE1C333KBQ	0.033	S
	C924	F2A0J1020031	1000	
	C928	F0C2E1050005	1	
	C929	F1K1H475A199	4.7	S
	C930	ECUV1C563KBV	0.056	
	C931	ECUV1C474KBV	0.47	
	C932	ECUE1A104KBQ	0.1	
	C933	ECJ1VB0G106M	10	S
	C934	ECUE1H102KBQ	0.001	S
	C935	ECUE1H102KBQ	0.001	S
	C936	ECUE1H102KBQ	0.001	S
	C937	F2A1C1010119	100	
	C940	ECUE1C103KBQ	0.01	S
	C941	ECUE1H100DCQ	10p	S
	C942	ECUE1H100DCQ	10p	S
	C943	ECUE1H100DCQ	10p	S
	C944	ECUE1H100DCQ	10p	S
			(OTHERS)	
⚠	F301	K5H302Y00003	FUSE	
	IC902	B3PBA0000138	PHOTO ELECTRIC TRANSDUCER	
	MIC1	L0CBAY000018	BUILTIN-MICROPHONE	
<u> </u>	P101	D4DAY220A022	THERMISTOR	
	X501	ној138500011	CRYSTAL OSCILLATOR (*1)	

16.5.1.3. Operational P.C. Board Parts

Safety	Ref.	Part No.	Part Name & Description	Remarks
	PCB2	PNWP2TG4771H	OPERATIONAL P.C.BOARD ASS'Y (RTL)	
			(LEDS)	
	LED901	LNJ237W82RA	DIODE(SI)	
_	LED902	LNJ237W82RA	DIODE(SI)	
	LED903	LNJ237W82RA	DIODE(SI)	
			(RESISTORS)	
	R10	PQ4R10XJ221	220	s
	R11	PQ4R10XJ221	220	s
	R12	PQ4R10XJ105	1M	S
	R7	PQ4R10XJ560	56	S
	R8	PQ4R10XJ221	220	S
	R9	PQ4R10XJ560	56	S
			(CAPACITORS)	
	C1	F1H1E1050001	1	
	C2	F1H1E1050001	1	
	C3	F1H1E1050001	1	
	C4	F1H1E1050001	1	
	C5	F1H1E1050001	1	
	C6	F1H1E1050001	1	
	C7	F1H1E1050001	1	
	C8	F1H1E1050001	1	
	C9	F1H1E1050001	1	
	C10	F1H1E1050001	1	
	C12	ECUV1H221JCV	220p	
	C13	ECUV1H221JCV	220p	
	C14	ECUV1H101JCV	100p	
	C15	ECUV1H101JCV	100p	
	C16	ECUV1H221JCV	220p	
			(CONNECTORS)	
	CN903	K1MN20BA0110	CONNECTOR	
			(SWITCH)	
	SW901	K0L1LB000021	SPECIAL SWITCH	

16.5.1.4. LED Board parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
			(LEDS)	
	LED1	B3AFB0000211	LED	
	LED2	B3AFB0000211	LED	
			(RESISTORS)	
	R14	ERJ3GEYJ330	33	S
	R15	ERJ3GEYJ330	33	S

16.5.2. Portable

16.5.2.1. Cabinet and Electrical Parts

Safety	Ref.	Part No.	Part Name & Description	Pomarka
barecy	No.	rait No.	rait Name & Description	Kemarks
	101	PNGP1228Z1	PANEL, LCD	PMMA-HB
	102	PNYE1066Z	TAPE, DOUBLE SIDED	
	103	PNKM1257Z1	CABINET BODY	ABS-HB
	104	PNGT6775Z	NAME PLATE	
	105	L0AD01A00026	RECEIVER	
	106	PNYE1065Y	SPACER, CUSHION LCD	
	107	PNBC1354Z1	BUTTON, NAVIGATOR KEY	ABS-HB
	108	PNJK1149Z	KEYBOARD SWITCH	
	109	PNJT1027Y	BATTERY TERMINAL (L)	
	110	PNJT1026Y	BATTERY TERMINAL (R)	
	111	PNJK1150Z	RUBBER PARTS, SIDE	
			SWITCH	
	112	PQHR11315Z	GUIDE, SPEAKER	ABS-HB
	113	L0AA02A00096	SPEAKER	
	114	PQHS10784Y	SPACER, SPEAKER NET	
	115	PQJC10056W	BATTERY TERMINAL	
	116	PNKE1131Z1	COVER, EP CAP	
	117	PNKF1229Z1	CABINET COVER	ABS-HB
	118	PNHR1588Z	OPTIC CONDUCTIVE PARTS, LED LENS	PS-HB
	119	PNQT2006Z	LABEL, ATTENTION	
	120	PNQT2335Z	LABEL, BATTERY	
	121	PNHS1079Z	SPACER	
	122	PNKK1066Z1	LID, BATTERY	ABS-HB
	123	PNYNTGA470BR	LID, BATTERY ASS'Y	

16.5.2.2. Main P.C. Board Parts

Note:

- (*1) Reconfirm the model No. written on the Portable's name plate when replacing PCB100. Because the model No. of the optional Portable may differ from the included Portable.
- (*2) When replacing IC3 or X1, make the adjustment using PNZZTG4771M. Refer to **Portable** (P.57) of Things to Do after Replacing IC or X'tal.
- (*3) When replacing the Portable LCD, See **How to Replace the Portable LCD** (P.48).

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB100	PNWP1TGA470R	MAIN P.C.BOARD ASS'Y (RTL) (*1)	
			(ICs)	
	IC1	C2HBCY000081	IC	
	IC3	PNWITGA470BR	IC (EEPROM) (*2)	
	IC4	CODBZYY00357	IC	
			(TRANSISTORS)	
	Q2	B1ADCF000040	TRANSISTOR(SI)	
	Q3	B1ABGE000011	TRANSISTOR(SI)	
	Q4	B1ADCF000040	TRANSISTOR(SI)	
	Q5	DRC9113Z0L	TRANSISTOR(SI)	
	Q6	DRC9113Z0L	TRANSISTOR(SI)	
	Q9	2SC6054JSL	TRANSISTOR(SI)	S
			(DIODES)	

				1
Safety		Part No.	Part Name & Description	Remarks
	No.			
	D13	B0BC4R3A0006		
	D14	B0BC4R3A0006	DIODE (SI)	
	D21	B0BC4R3A0006	DIODE(SI)	
	D22	B0BC4R3A0006	DIODE(SI)	
	DA801	B0DDCD000001	DIODE(SI)	
			(LEDS)	
	LED1	B3ACB0000190		
	LED2	B3ACB0000190		
	LED3	B3ACB0000190		
	LED4	B3ACB0000190		
	LED5	B3ACB0000190	LED	
	LED6	B3ACB0000190	LED	
	LED11	B3ACB0000190	LED	
	LED12	B3ACB0000190	LED	
			(COILS)	
	L4	G1CR18J00004		
	C812	PQLQR4C8N2J	COIL	S
	COIZ	FQDQR4C0N20		
		-10001 1-010	(RESISTOR ARRAYS)	_
	RA2		COMPONENTS PARTS	S
	RA3	D1H83314A013	COMPONENTS PARTS	S
	RA4	D1H433220001	COMPONENTS PARTS	
	RA5	EXB28V332JX	COMPONENTS PARTS	
			(IC FILTER)	
	L1	J0JCC0000286	IC FILTER	
	L10	J0JCC0000286		
	L3	J0JDC0000045		
	L7	J0JCC0000276		
	L75	J0JCC0000286		
			(RESISTORS)	
	R2	ERJ2GEJ303	30k	
	R3	D0GA152JA021	1.5k	
	R4	D0GA473JA021	47k	
	R6	D0GA103JA021	10k	
	R7	D0GA104JA021		
	R8	PQ4R18XJ3R3	3.3	S
	R9	ERJ2GEJ303	30k	
	R21	D0GA104JA021	100k	
	R22	D0GA332JA015	3.3k	
	R23	ERJ2GEYJ391	390	S
	R24	ERJ2GEJ100	10	S
	R25	D0GA222JA021	2.2k	
	R26	D0GA332JA015		
	R27	D0GA222JA021		
	R28	D0GA222JA021	1	
	R31	ERJ2RKF1003	100k	
	R32	D0GA104JA021	100k	
	R33	ERJ2RKF1003	100k	
	R34	ERJ2GEYJ391	390	S
	R45	ERJ6RSJR10V	0.1	
	R50	D0GA151JA021		
	R51	D0GA151JA021		
	R60	D0GA222JA021		
	R66	D0GA103JA021		
	R67	D0GA103JA021		
	R68	D0GA103JA021		
	R69	D0GA103JA021	10k	
	R70	D0GA470JA021	47	
	R73	D0GA330JA015	33	
	R74	D0GA330JA015	33	
-	R80	D0GA101JA021		
—	R806	ERJ2GEJ471	470	S
	R807	ERJ2GEJ471	470	S
	L8	ERJ2GEJ100	10	S
	L9	ERJ2GE0R00	0	S
			(CAPACITORS)	
	C1	EEE0JA221WP	220	
	C2	EEE0JA221WP	220	
	C3	EEE0JA221WP	220	
	C4	ECUE1H390JCQ		
-			=	
	C5	ECUE1A104KBQ		
	C6	ECUE1A104KBQ		
	C9	ECUE1H390JCQ	_	
	C10	ECUE1H390JCQ	39p	L

KX-TG4771B/KX-TG4772B/KX-TG4773B/KX-TGA470B

	1B/KX-TG4	772B/KX-TG4773B/	KX-TGA470B	
Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C11	ECUE1A104KBQ	0.1	
	C12	PQCUV0J106KB	10	S
	C13	ECUE1A104KBQ	0.1	
	C14	ECUV1C393KBV	0.039	
	C15	ECUE1H390JCQ	39p	
	C16	F1J0J2260002	22	
	C17	ECUE1H100DCQ	10p	S
	C18	ECUE1H100DCQ		S
	C20	ECJ1VB0G106M		S
	C21	ECUE0J105KBQ		_
	C22	ECUE1A104KBQ		
	C23	ECUE1A104KBQ		
	C24	ECUE0J105KBQ		
	C25	ECUV1A225KBV		S
	C26			
		ECJ1VB0G106M		S
	C27	ECUE1H102KBQ		S
	C29	ECUV1A105KBV		
	C30	ECUV1A105KBV		
	C31	ECJ1VB0G106M		S
	C32	ECUE0J105KBQ		
	C33	ECUE1A104KBQ		
	C34	ECUE1H390JCQ	39p	
	C36	ECUE1A104KBQ	0.1	
	C37	ECJ1VB0G106M	10	S
	C39	ECUE1H102KBQ	0.001	S
	C40	ECUE1A104KBQ	0.1	
	C41	ECUE1A104KBQ	0.1	
	C42	ECUE1H102KBQ	0.001	S
	C43	ECUE1A104KBQ		
	C44	ECUE0J105KBQ		
	C45	ECUE1A104KBQ		
	C46	ECUE1H100DCQ		S
	C51	ECJ1VB0G106M		s
	C52	ECUE1H100DCQ		s
	C52	ECUE1H100DCQ		S
				5
	C56	ECUE0J105KBQ		
	C57	ECUE0J105KBQ		
	C58	ECUE0J105KBQ		
	C68	ECUE0J105KBQ		
	C69	ECUE1A104KBQ		
	C72	ECUE1H100DCQ		S
	C73	ECUE1H100DCQ		S
	C76	ECUE1H100DCQ		S
	C77	ECUE1H100DCQ	10p	S
	C79	ECUE1H101JCQ	100p	
	C80	ECUV1C393KBV	0.039	
	C81	ECUE1H101JCQ	100p	
	C82	ECUE1H471KBQ	470p	S
	C83	ECUE1H100DCQ	10p	S
	C84	ECUE1H102KBQ	0.001	S
	C87	ECUE1H102KBQ	0.001	S
	C88	ECUE1H100DCQ	10p	S
	C89	ECUE1H100DCQ		S
		ECUE1A104KBQ		
	C90	TCOLLIII O 11CD O	0.1	
1	C90	ECUV1C105KBV		
1			1	
1	C91 C92	ECUV1C105KBV ECUE0J105KBQ	1	
⋖	C91 C92 C93	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV	1 1 1	S
\langle	C91 C92 C93 C96	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ	1 1 1 10p	
\langle	C91 C92 C93 C96	ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCQ	1 1 1 10p 10p	S
\leq	C91 C92 C93 C96 C97	ECUV1C105KBV ECUE0J105KBV ECUV1C105KBV ECUE1H100DCQ ECUV1H100DCV	1 1 1 10p 10p 10p	
{	C91 C92 C93 C96 C97 C801	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCQ ECUV1H100DCV F1G1H2R0A480	1 1 1 10p 10p 10p 2p	
{	C91 C92 C93 C96 C97 C801 C802	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCQ ECUV1H100DCV F1G1H2R0A480 F1G1H1R3A480	1 1 1 10p 10p 10p 2p 1.3p	
	C91 C92 C93 C96 C97 C801 C802 C803	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV ECUV1H100DCV F1G1H2R0A480 F1G1H1R3A480 F1G1H1R8A480	1 1 1 10p 10p 10p 2p 1.3p	
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV FIG1H2R0A480 FIG1H1R3A480 FIG1H1R8A480 FIG1H2R4A480	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p	
<	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV FIG1H2R0A480 FIG1H1R3A480 FIG1H1R8A480 FIG1H2R4A480 FIG1H2R4A480	1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.4p	
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV FIG1H2R0A480 FIG1H1R3A480 FIG1H1R8A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480	1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.4p 2.5p	S
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV FIG1H2R0A480 FIG1H1R3A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R5A480 ECUE1H101JCQ	1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.4p 2.5p 100p	
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811 C813	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV F1G1H2R0A480 F1G1H1R3A480 F1G1H1R8A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R5A480 ECUE1H101JCQ F1G1H1R6A480	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.5p 100p	S
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV FIG1H2R0A480 FIG1H1R3A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R4A480 FIG1H2R5A480 ECUE1H101JCQ	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.5p 100p	S
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811 C813	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV F1G1H2R0A480 F1G1H1R3A480 F1G1H1R8A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R5A480 ECUE1H101JCQ F1G1H1R6A480	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.5p 100p	S
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811 C813 C820	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV F1G1H2R0A480 F1G1H1R3A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R5A480 ECUE1H101JCQ F1G1H1R6A480 F1G1H1R6A480	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.4p 2.5p 100p 1.6p 1.8p	s
	C91 C92 C93 C96 C97 C801 C802 C803 C804 C805 C806 C810 C811 C813 C820 C822	ECUV1C105KBV ECUE0J105KBQ ECUV1C105KBV ECUE1H100DCQ ECUE1H100DCV F1G1H2R0A480 F1G1H1R3A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R4A480 F1G1H2R5A480 ECUE1H101JCQ F1G1H1R6A480 F1G1H1R6A480 ECUE1H100DCQ	1 1 1 10p 10p 10p 2p 1.3p 1.8p 2.4p 2.4p 2.5p 100p 1.6p 1.8p 1.8p	S

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	C897	F1G1H240A557	24p	
	L809	F1G1H1R0A480	1p	
			(OTHERS)	
<u> </u>	F1	K5H252Y00002	FUSE	
	E101	L5DYBYY00043	LIQUID CRYSTAL DISPLAY (*3)	
	E102	PNHX1569Z	PLASTIC PARTS, DEFFUSION SHEET	
	E103	PNHX1518Z	PLASTIC PARTS, LCD COVER SHEET	
	E104	PNHR1587Z	PLASTIC PARTS, TRANSPARENT PLATE	PMMA-HB
	E105	PNHR1586Z	GUIDE	ABS-HB
	E106	PQHG10729Z	RUBBER PARTS, RECEIVER	
	E107	PNVE1002Z	BATTERY TERMINAL	
	MIC100	L0CBAY000053	MICROPHONE	
	VOL_DW	K0H1BB000094	PUSH SWITCH	
	VOL_UP	K0H1BB000094	PUSH SWITCH	
	X1	н0J138500003	CRYSTAL OSCILLATOR (*2)	S
	CN4	K2HD103D0001	JACK/SOCKET	

16.5.2.3. LED Board Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
		// 1	(LED)	
	WLED	B3AFB0000370	LED	

16.5.3. Charger Unit

16.5.3.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
X	200	PNLC1029ZB	CHARGER UNIT ASS'Y without NAME PLATE (RTL)	
	200-1	PNKM1258Z1	CABINET BODY	PS-HB
	200-2	PNJT1105Z	BATTERY TERMINAL	
	200-3	PNKF1150Z1	CABINET COVER	PS-HB
	200-4	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	
	201	PNGT6776Z	NAME LABEL	

16.5.3.2. Main P.C. Board Parts

Safety	Ref. No.	Part No.	Part Name & Description Remarks
	PCB200	PNWPTGA470CH	PC BOARD W/COMPONENT (RTL)
			(DIODE)
	D1	B0ECKM000008	DIODE(SI)
			(RESISTORS)
	R1	ERJ14YJ1R0U	1
	R2	ERJ14YJ1R0U	1
			(JACK)
	J1	K2ECYB000001	JACK/SOCKET
			(FUSE)
A	F1	К5Н302Y00003	FUSE

16.5.4. Accessories and Packing Materials Note:

(*1) You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

16.5.4.1. KX-TG4771B

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	A1	PNLXP1005Z	HANDLE/HANDSET	
⚠	A2	PQJA10075Z	CORD, TELEPHONE	

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	A3	PQJA212V	CORD, HANDSET	
	A4	PNKE1132Z1	HANGER, BELT CLIP	ABS-HB
⚠	A5	PNLV226Z	AC ADAPTOR	
	A6	PNQX5103Z	INSTRUCTION BOOK (*1)	
	P1	PNPK3509001Z	GIFT BOX	
	P2	PNPD1612Z	CUSHION	

16.5.4.2. KX-TG4772B

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	A101	PNLXP1005Z	HANDLE/HANDSET	
A	A102	PQJA10075Z	CORD, TELEPHONE	
	A103	PQJA212V	CORD, HANDSET	
	A104	PNKE1132Z1	HANGER, BELT CLIP	ABS-HB
A	A105	PNLV226Z	AC ADAPTOR	
	A106	PNQX5103Z	INSTRUCTION BOOK (*1)	
	P101	PNPK3510001Z	GIFT BOX	
	P102	PNPD1613Z	CUSHION	

16.5.4.3. KX-TG4773B

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	A201	PNLXP1005Z	HANDLE/HANDSET	
⚠	A202	PQJA10075Z	CORD, TELEPHONE	
	A203	PQJA212V	CORD, HANDSET	
	A204	PNKE1132Z1	HANGER, BELT CLIP	ABS-HB
⚠	A205	PNLV226Z	AC ADAPTOR	
	A206	PNQX5103Z	INSTRUCTION BOOK (*1)	
	P201	PNPK3511001Z	GIFT BOX	
	P202	PNPD1614Z	CUSHION	

16.5.4.4. KX-TGA470B

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
\triangle	A301	PNLV226Z	AC ADAPTOR	
	A302	PNQX5093Z	INSTRUCTION BOOK (*1)	
	A303	PNKE1132Z1	HANGER, BELT CLIP	ABS-HB
	P301	PNPK3490001Z	GIFT BOX	
	P302	PNPD1648Z	CUSHION	

16.5.5. Screws

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	A	XTB26+8GFJ	TAPPING SCREW	
	В	XTB2+8GFJ	TAPPING SCREW	

16.5.6. Fixtures and Tools

Note:

- (*1) See Equipment Required (P.49), and The Setting Method of JIG (P.49) $\,$
- (*2) When replacing the Portable LCD, See **How to** Replace the Portable LCD (P.48)

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
		PQZZ1CD300E	JIG CABLE (*1)	
		PNZZTG4771M	BATCH FILE CD-ROM (*1)	
		PQZZ430PIR	TIP OF SOLDERING IRON (*2)	
		PQZZ430PRB	RUBBER OF SOLDERING IRON (*2)	

YK/N KXTG4771B KXTG4772B KXTG4773B KXTGA470B